

SERVICE MANUAL

MODEL: LAN5200WR1

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CAR NAVIGATION SYSTEM
MODEL: LAN5200WR1

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RENAULT

P/NO : AFN72978857

FEBRUARY, 2012

RENAULT

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SECTION 1 SUMMARY

SERVICING PRECAUTIONS

1. Always disconnect the power source before:

- 1) Removing or reinstalling any component, circuit board, module or any other instrument assembly.
- 2) Disconnecting or reconnecting any instrument electrical plug or other electrical connection.
- 3) Connecting a test substitute in parallel with an electrolytic capacitor in the instrument.

CAUTION: A wrong part substitution or incorrect polarity installation of electrolytic capacitors may result in an explosion hazard.

2. Do not defeat any plug/socket B+ voltage interlocks with which instruments covered by this service manual might be equipped.

3. Do not apply power to this instrument and or any of its electrical assemblies unless all solid-state device heat sinks are correctly installed.

4. Always connect a test instrument's ground lead to the instrument chassis ground before connecting the test instrument positive lead. Always remove the test instrument ground lead last.

- 1) The service precautions are indicated or printed on the cabinet, chassis or components. When servicing, follow the printed or indicated service precautions and service materials.
- 2) The Components used in the unit have a specified flammability and dielectric strength. When replacing any components, use components which have the same ratings. Components marked in the circuit diagram are important for safety or for the characteristics of the unit. Always replace with the exact components.
- 3) An insulation tube or tape is sometimes used and some components are raised above the printed writing board for safety. The internal wiring is sometimes clamped to prevent contact with heating components. Install them as they were.
- 4) After servicing always check that the removed screws, components and wiring have been installed correctly and that the portion around the service part has not been damaged. Further check the insulation between the blades of attachment plug and accessible conductive parts.

ESD PRECAUTIONS

Electrostatically Sensitive Devices (ESD)

Some semiconductor (solid state) devices can be damaged easily by static electricity. Such components commonly are called electrostatically sensitive devices (ESD). Examples of typical ESD devices are integrated circuits and some field-effect transistors and semiconductor chip components. The following techniques should be used to help reduce the incidence of component damage caused by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging wrist strap device, which should be removed for potential shock reasons prior to applying power to the unit under test.
 2. After removing an electrical assembly equipped with ESD devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.
 3. Use only a grounded-tip soldering iron to solder or unsolder ESD devices.
 4. Use only an anti-static solder removal device. Some solder removal devices not classified as "anti-static" can generate electrical charges sufficient to damage ESD devices.
 5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ESD devices.
 6. Do not remove a replacement ESD device from its protective package until immediately before you are ready to install it. (Most replacement ESD devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive materials).
 7. Immediately before removing the protective material from the leads of a replacement ESD device, touch the protective material to the chassis or circuit assembly into which the device will be installed.
- CAUTION : BE SURE NO POWER IS APPLIED TO THE CHASSIS OR CIRCUIT, AND OBSERVE ALL OTHER SAFETY PRECAUTIONS.**
8. Minimize bodily motions when handling unpackaged replacement ESD devices. (Otherwise harmless motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity sufficient to damage an ESD device).

CAUTION. GRAPHIC SYMBOLS

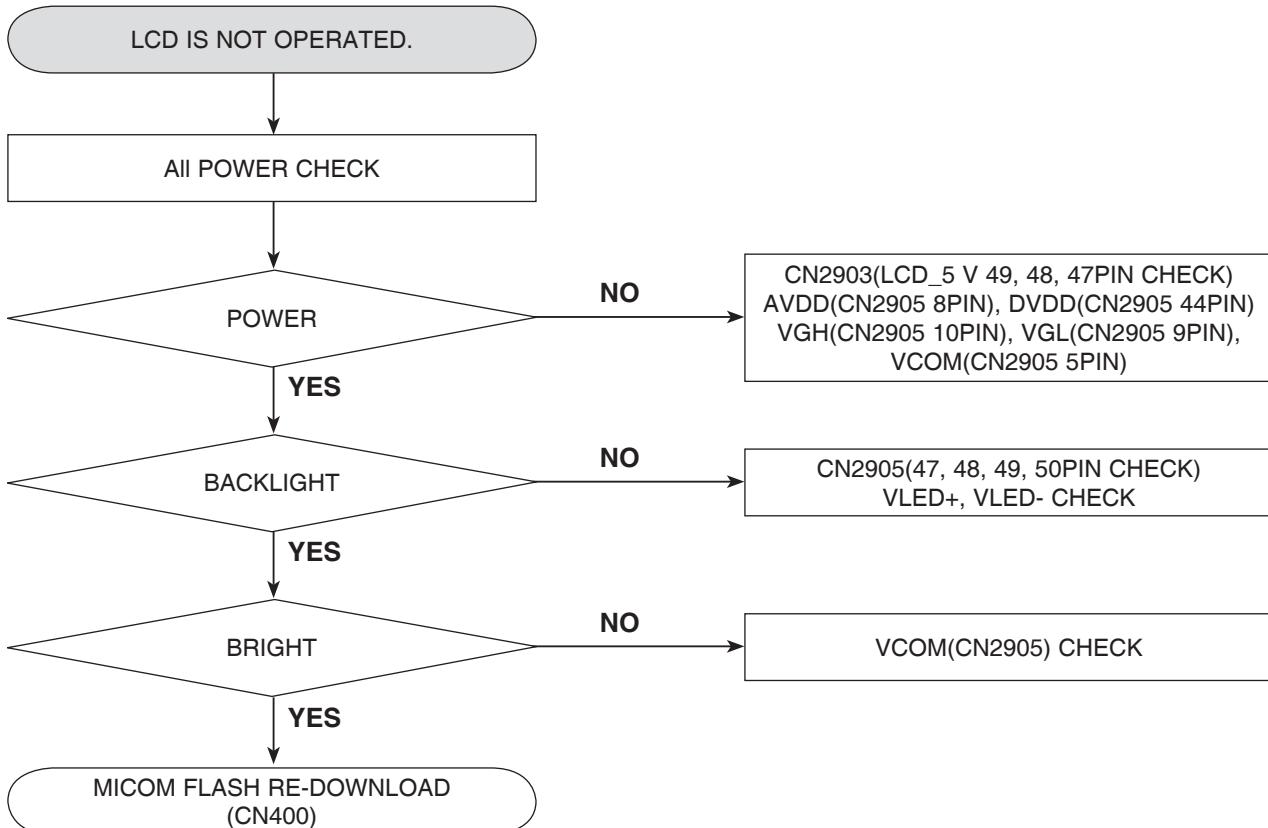
	THE LIGHTNING FLASH WITH ARROWHEAD SYMBOL, WITHIN AN EQUILATERAL TRIANGLE, IS INTENDED TO ALERT THE SERVICE PERSONNEL TO THE PRESENCE OF UNINSULATED "DANGEROUS VOLTAGE" THAT MAY BE OF SUFFICIENT MAGNITUDE TO CONSTITUTE A RISK OF ELECTRIC SHOCK.
	THE EXCLAMATION POINT WITHIN AN EQUILATERAL TRIANGLE IS INTENDED TO ALERT THE SERVICE PERSONNEL TO THE PRESENCE OF IMPORTANT SAFETY INFORMATION IN SERVICE LITERATURE.

SECTION 2 ELECTRICAL

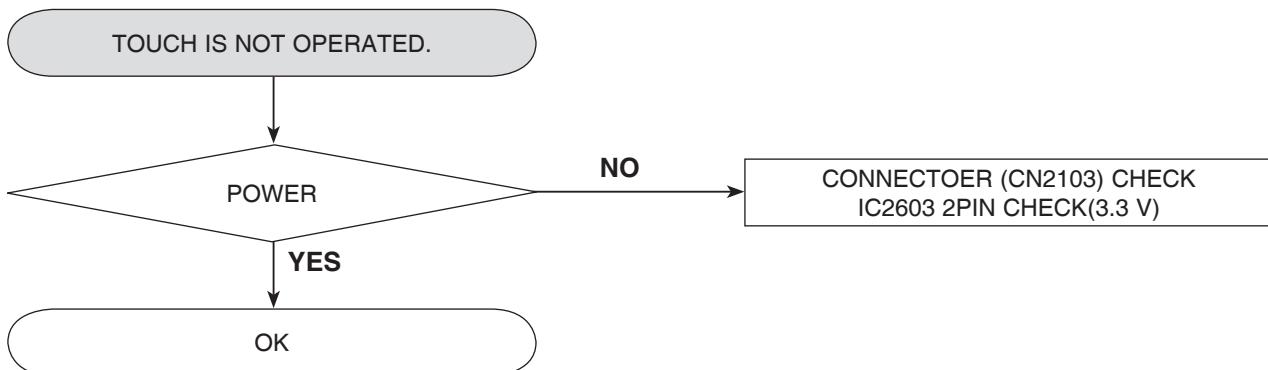
ELECTRICAL TROUBLESHOOTING GUIDE

1. FRONT PART

• FRONT_LCD ERROR

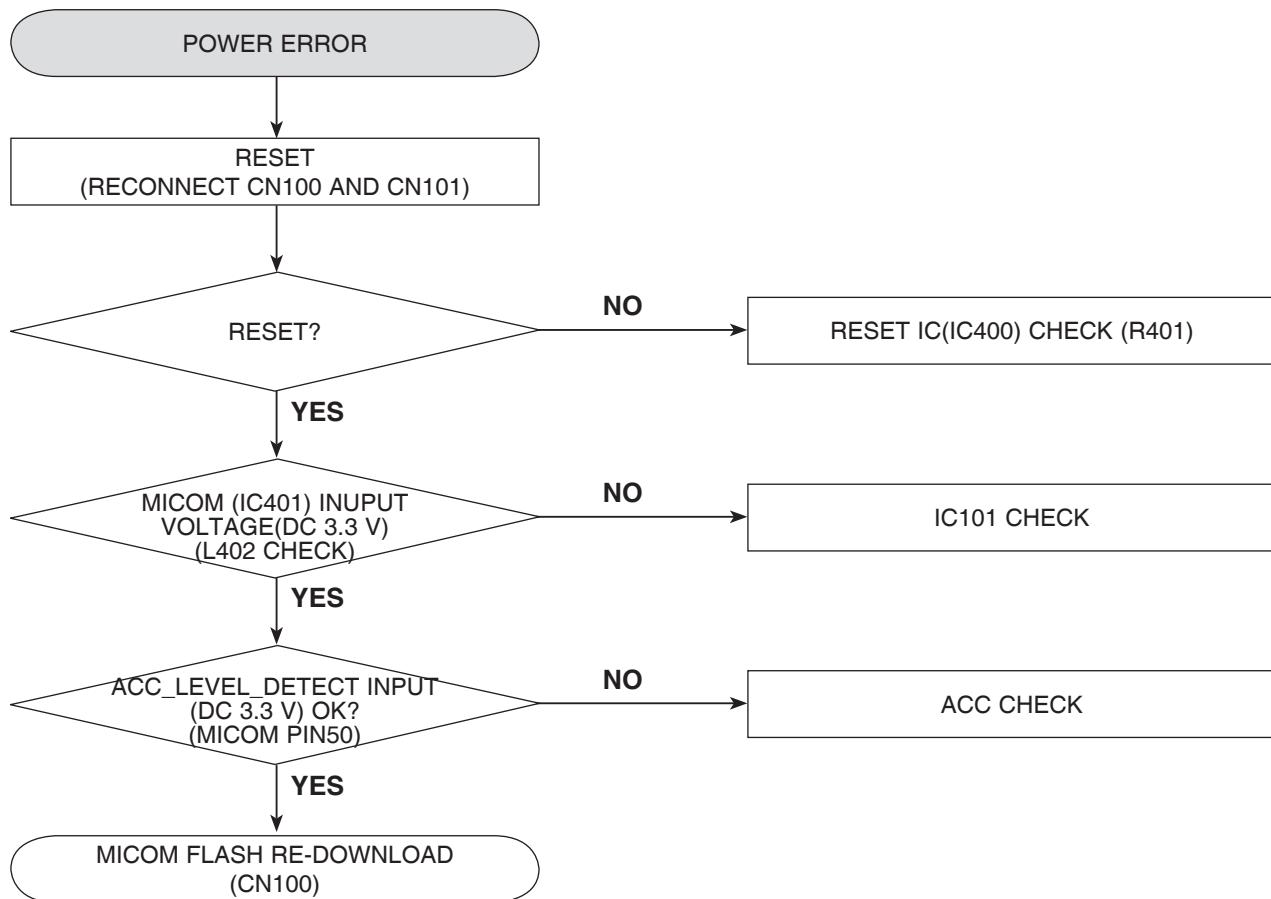


• FRONT_TOUCH ERROR

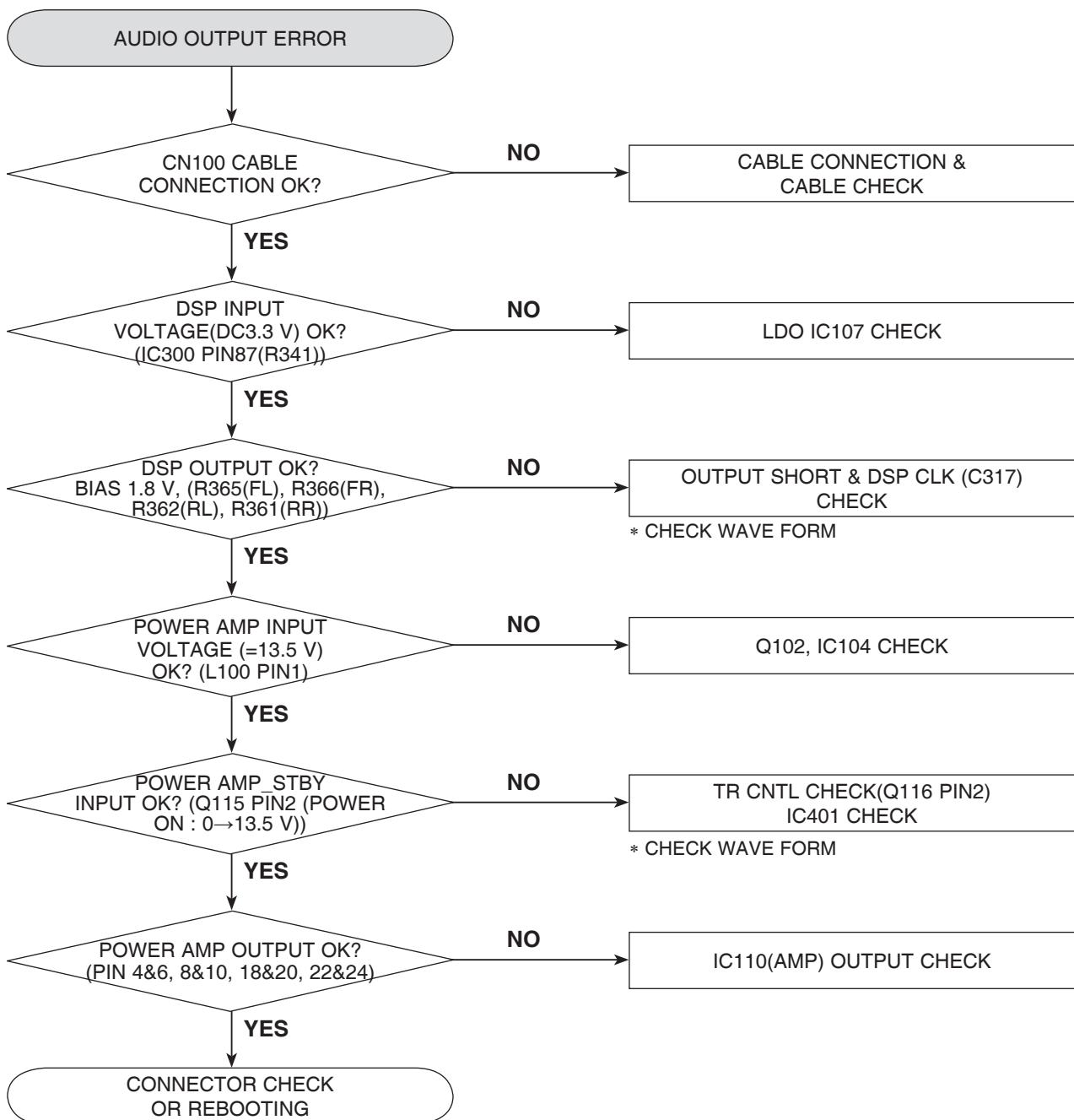


2. AUDIO PART

• AUDIO MICOM OPERATING ERROR



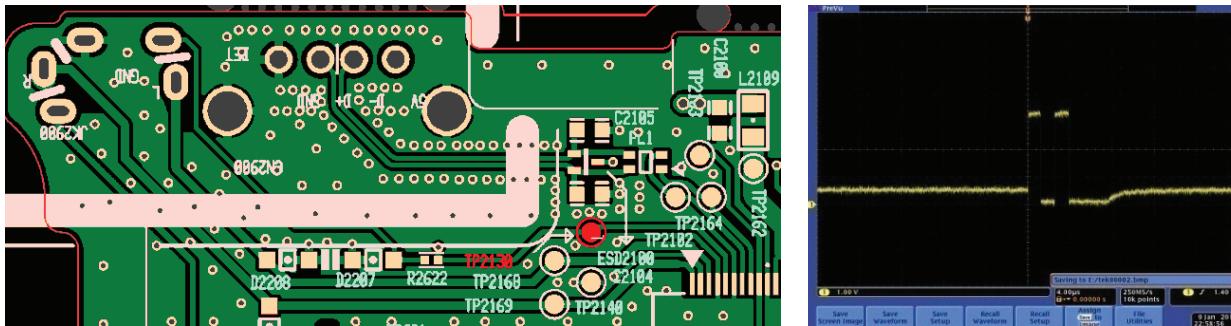
• AUDIO OUTPUT ERROR



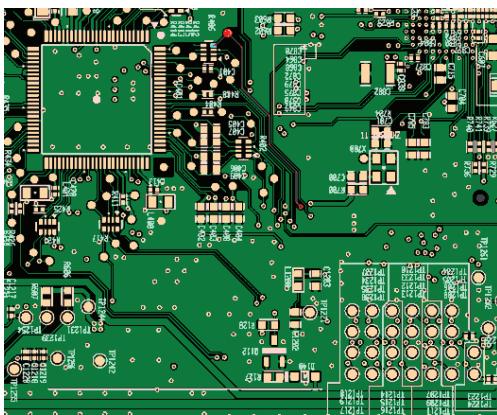
• AUX SOURCE CHECKING

[AUX source input checking]

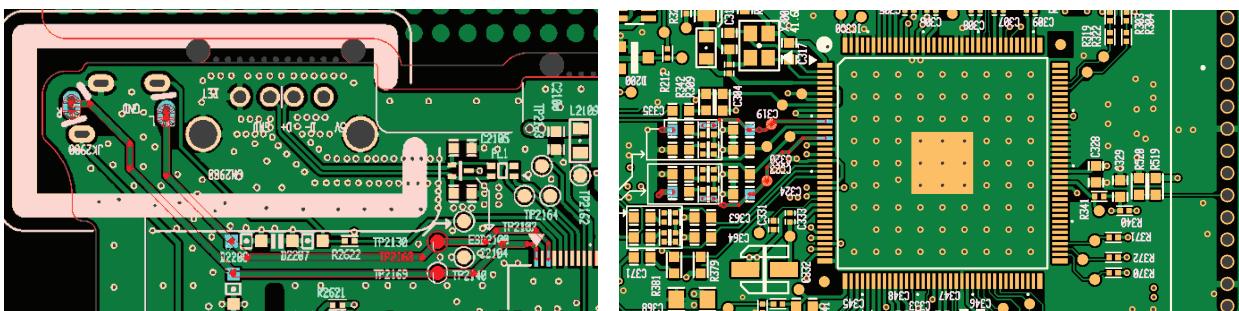
1. Check front PCB TP2130 (Detect signal)
→ If it is failed, check AUX connector.



2. Check MAIN PCB. (Detect signal)



3. Check AUX Left, Right signal. (front : TP2168, TP2169 / MAIN : C319, C324)

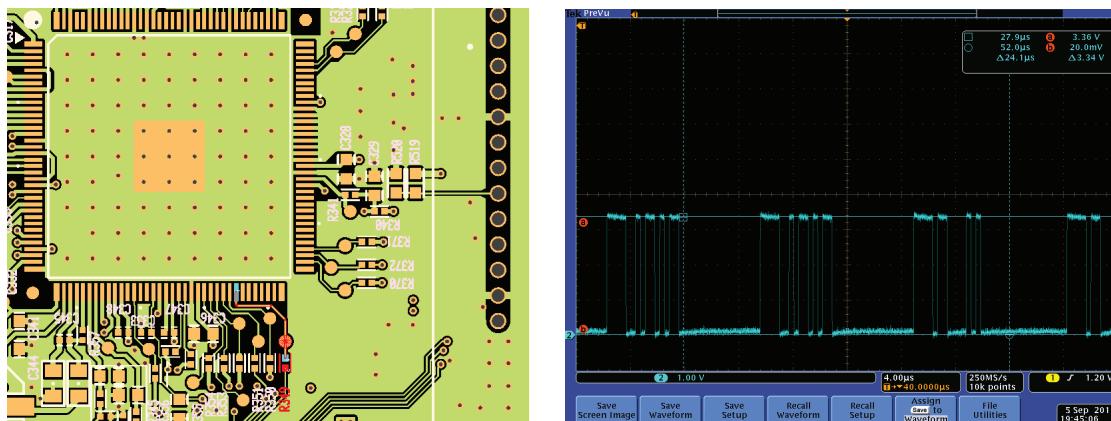


4. If there are different signals between front & MAIN.
→ Check 40pin cable.

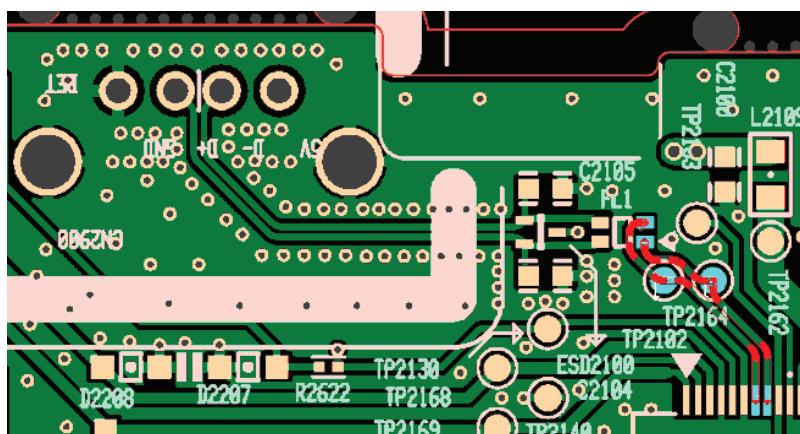
• USB, IPOD, BLUETOOTH SOURCE CHECKING

[I2S data signal checking]

1. Check Main PCB R349.
→ If it is not failed, check DSP chip.

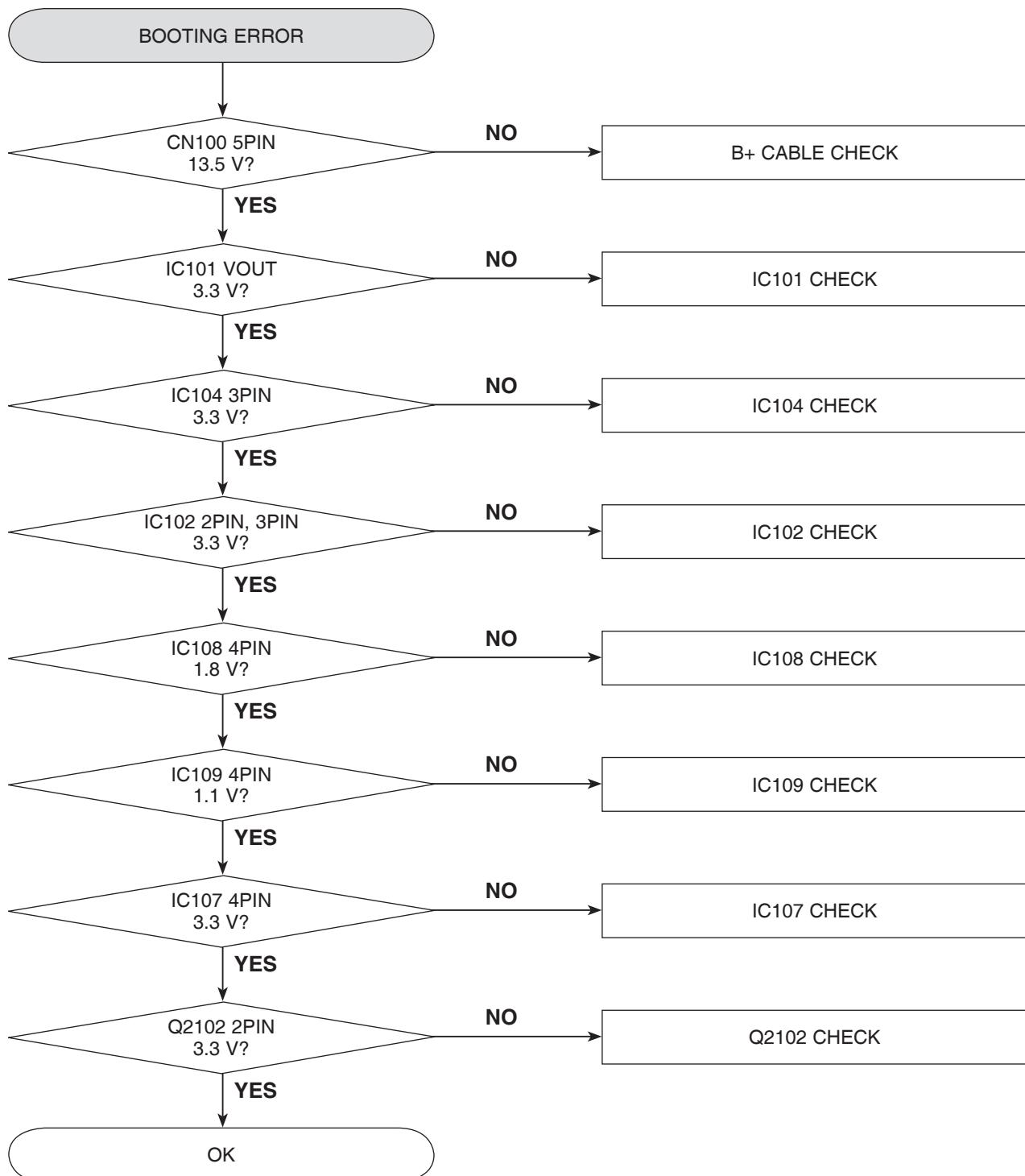


2. If R349 data is failed,
 - a. Bluetooth : check Bluetooth chip (PCM, BT_Rx, BT_Tx), 40pin cable and CPU.
 - b. USB, IPOD : check TP2102, TP2164.
 - If it is OK : check 40pin cable and CPU.
 - If it is failed : check USB connector

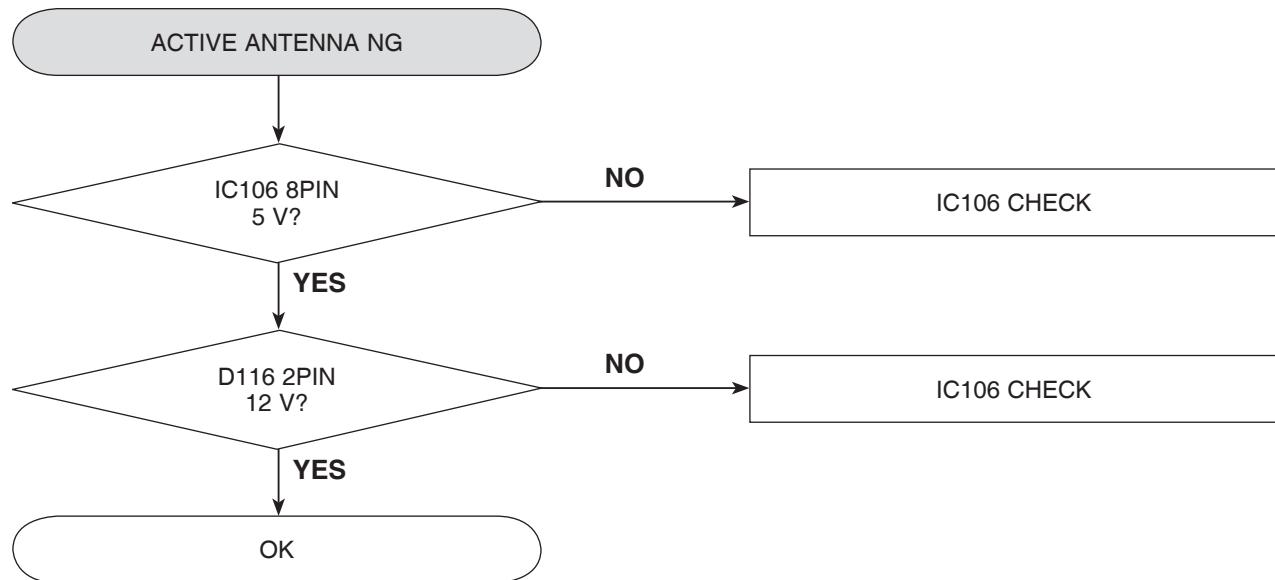


3. POWER PART

- SET BOOTING ERROR

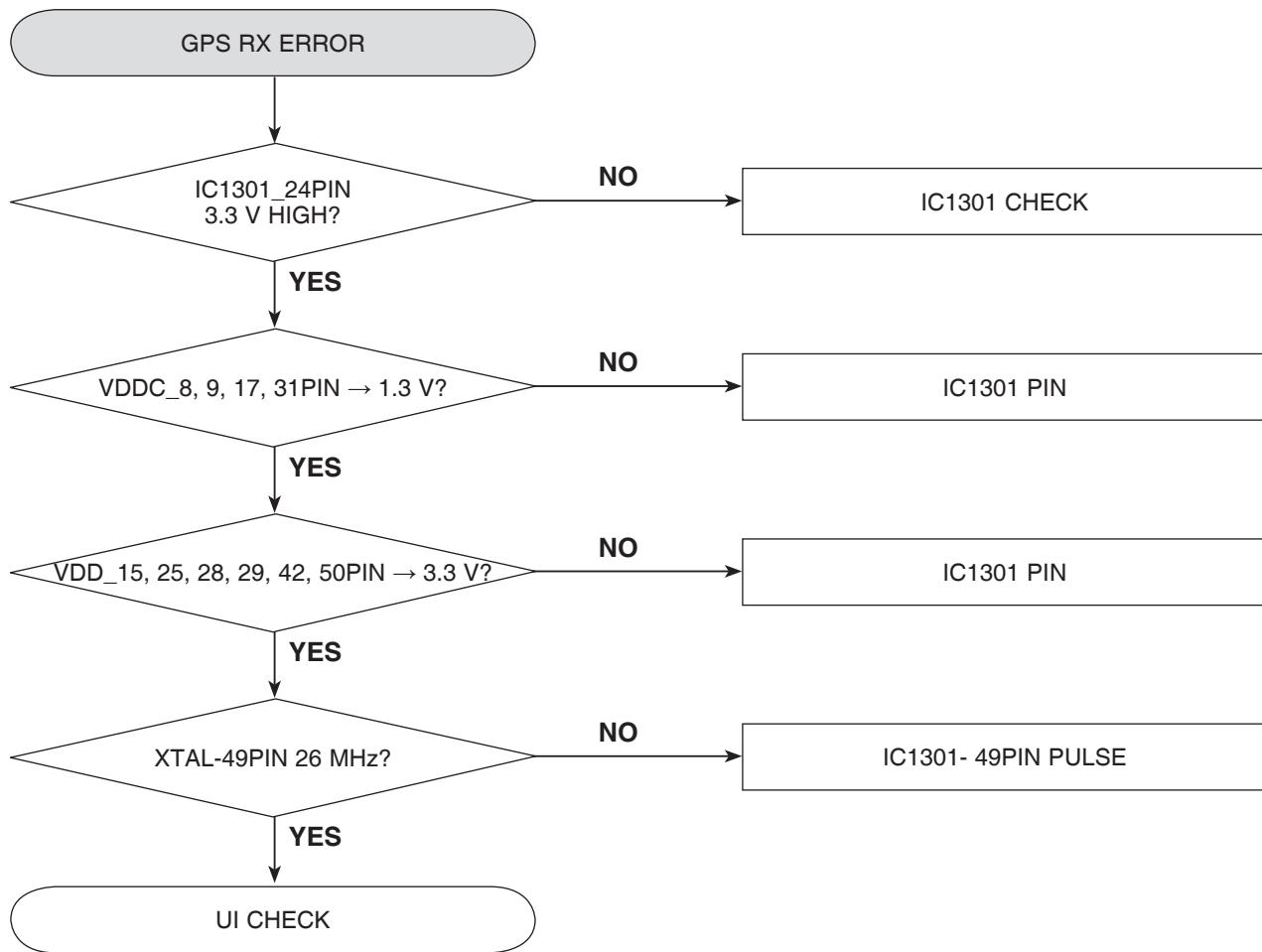


- ACTIVE ANTENNA NG

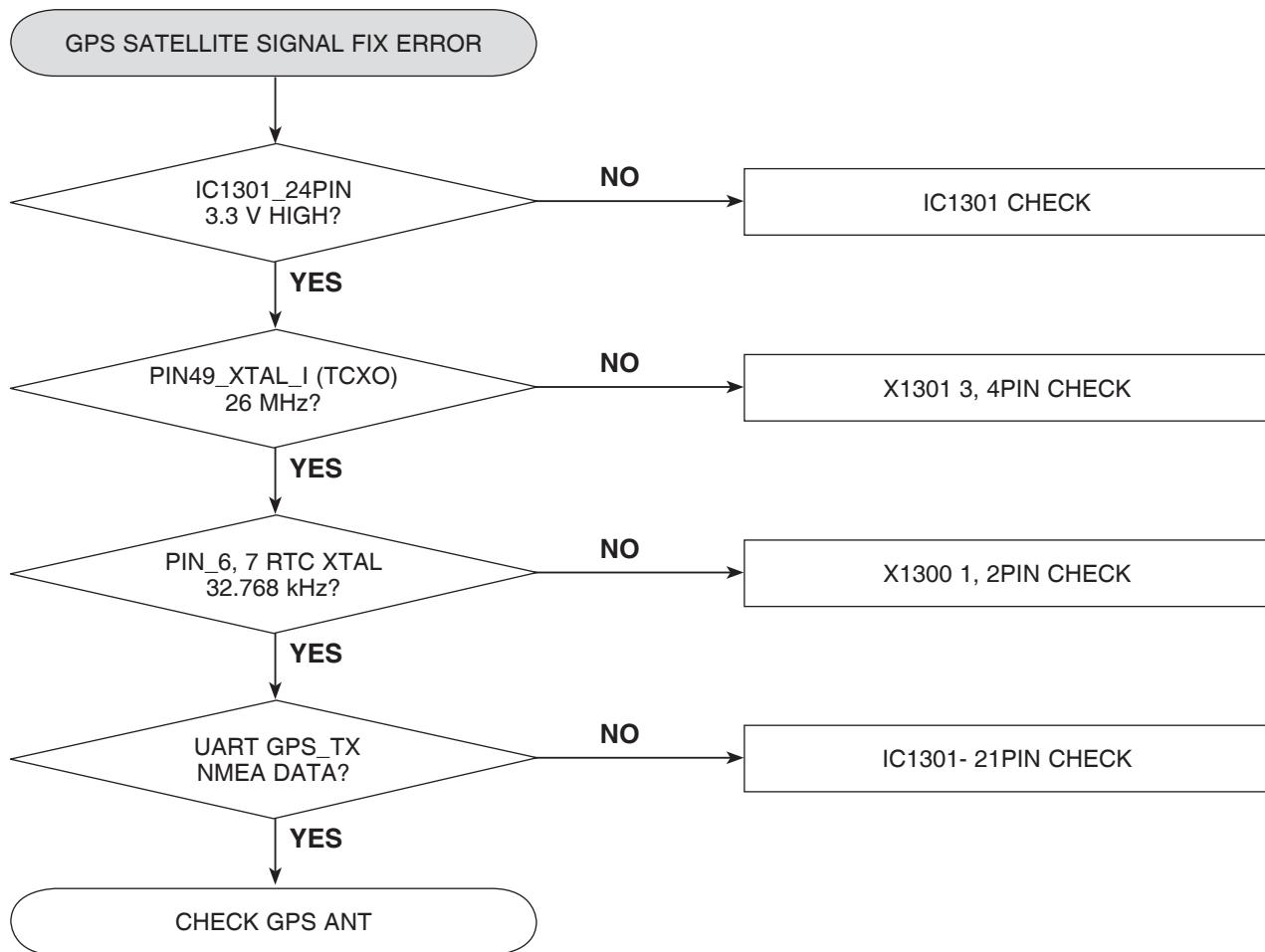


4. GPS PART

- SET BOOTING ERROR

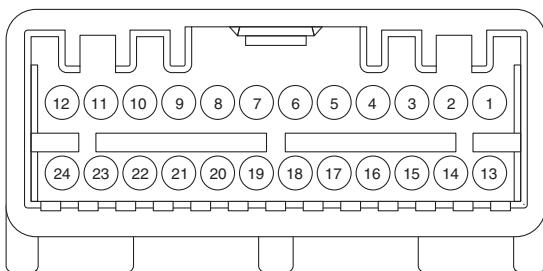


• GPS SATELLITE SIGNAL FIX ERROR



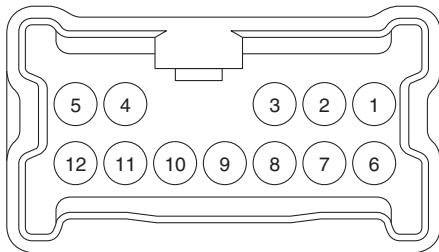
CONNECTOR TERMINAL FUNCTION

1. 24PIN SIGNAL CONNECTOR



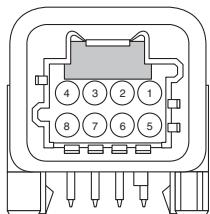
No.	Signal Name	Function
1	ILL	Illumination Signal
2	ACC	Wake-up Signal
3	REAR GEAR	Rear gear engaged
4	N.C	N.C
5	N.C	N.C
6	N.C	N.C
7	MIC_SIG	External microphone signal
8	PWR_MIC	External microphone supply
9	PWR_CAM	Rear camera power supply
10	CAM_IN +	Rear camera video signal +
11	AUX2_IN +	Line in mono +
12	INFO_AUX2_IN	Line in detection Audio switch function
13	SPEED	Vehicle speed
14	IGN	Wake-up signal
15	CAN_H	CAN High Multimedia
16	CAN_L	CAN Low Multimedia
17	N.C	N.C
18	N.C	N.C
19	MIC_GND	External Microphone ground
20	N.C	N.C
21	CAN_GND	Rear camera ground
22	CAM_IN -	Rear camera video signal -
23	AUX2_IN_GND	Line in mono -
24	AUX2_IN_SHIELD	Line in mono shield

2. 12PIN POWER / AUDIO CONNECTOR



No.	Signal Name	Function
1	HP AR G+	Left rear speaker +
2	HP AV G+	Left front speaker +
3	HP AV D+	Right front speaker +
4	N.C	N.C
5	BAT	Radio Power Supply
6	HP AR G-	Left rear speaker -
7	HP AV G-	Left front speaker -
8	HP AV D-	Right front speaker -
9	HP AR D+	Right Rear speaker +
10	HP AR D-	Right Rear speaker -
11	N.C	N.C
12	GND	Radio ground

3. 8PIN REMOTE CONTROL CONNECTOR



No.	Signal	Name Function
1	IN0	Steering wheel remote controller IN0
2	IN1	Steering wheel remote controller IN1
3	IN2	Steering wheel remote controller IN2
4	L0	Steering wheel remote controller L0
5	L1	Steering wheel remote controller L1
6	L2	Steering wheel remote controller L2
7	N.C	N.C
8	N.C	N.C

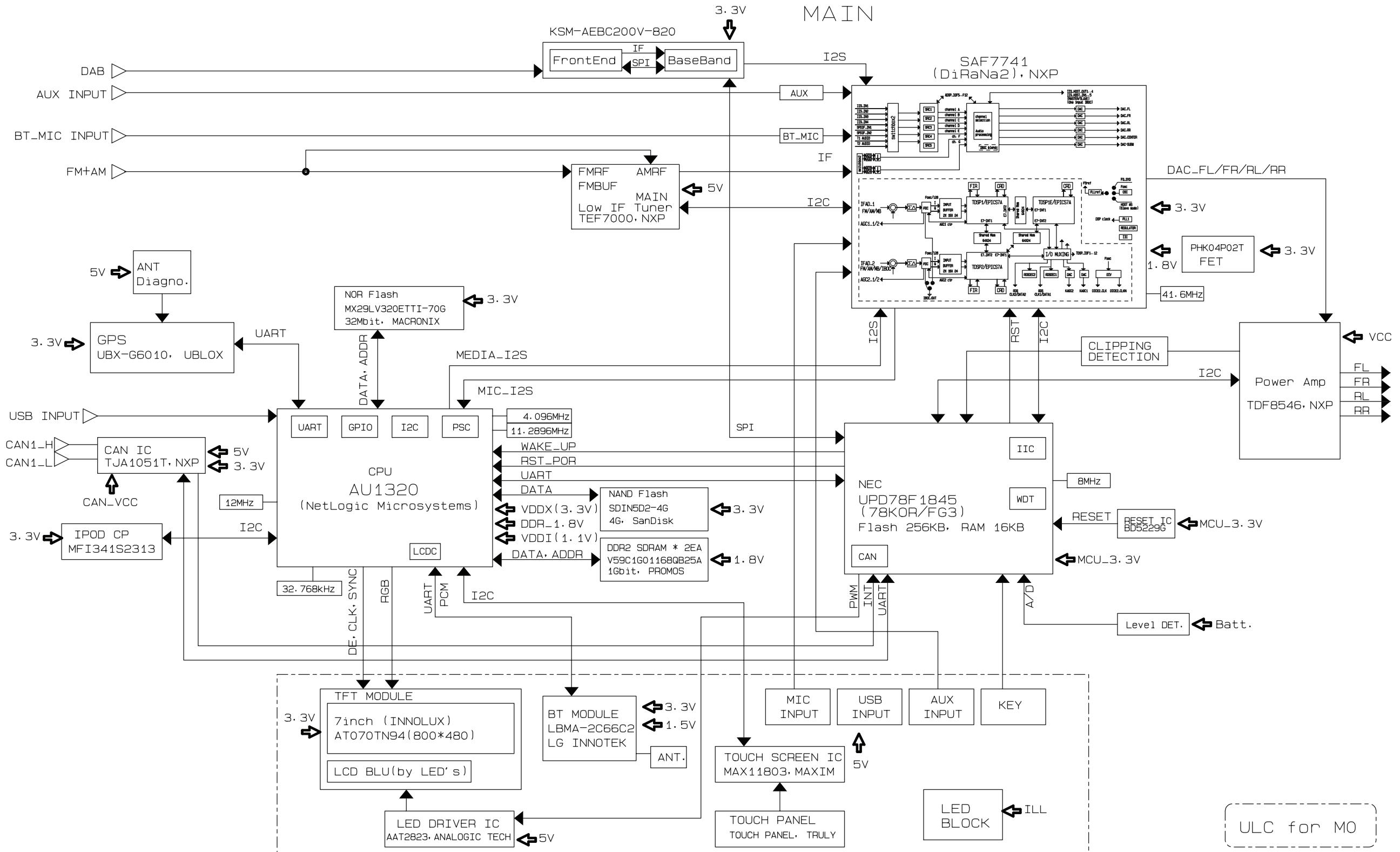
MEMO

IC1002 (SDIN5D2-4G), 153 BALLS
 EAN62328201 (TOP VIEW: see balls through package)

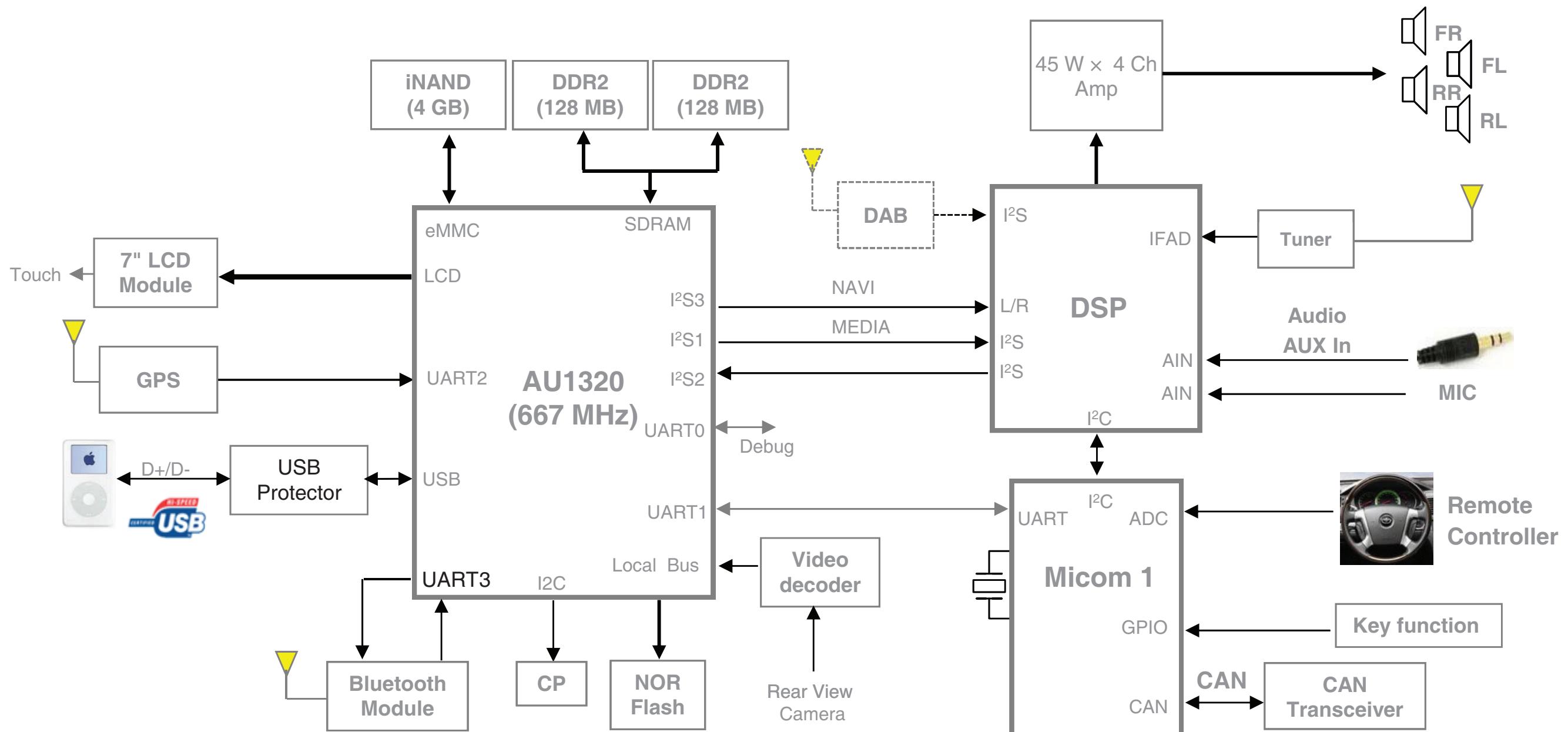
	1	2	3	4	5	6	7	8	9	10	11	12	13	14
A	NC	NC	DAT0	DAT1	DAT2	NC	NC	NC	NC	NC	NC	NC	NC	NC
	-	-	H/L	H/L	H/L	-	-	-	-	-	-	-	-	-
B	NC	DAT3	DAT4	DAT5	DAT6	DAT7	NC	NC	NC	NC	NC	NC	NC	NC
	-	H/L	H/L	H/L	H/L	H/L	-	-	-	-	-	-	-	-
C	NC	VDDi	NC	VSSQ	NC	VCCQ	NC	NC	NC	NC	NC	NC	NC	NC
	-	DGND	-	DGND	-	3.3 V	-	-	-	-	-	-	-	-
D	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC
	-	-	-	-	-	-	-	-	-	-	-	-	-	-
E	NC	NC	NC	NC	NC	VCC	VSS	NC	NC	NC	NC	NC	NC	NC
	-	-	-	-	-	3.3 V	DGND	-	-	-	-	-	-	-
F	NC	NC	NC	NC	VCC	NC	NC	NC	NC	NC	NC	NC	NC	NC
	-	-	-	-	3.3 V	-	-	-	-	-	-	-	-	-
G	NC	NC	NC	NC	VSS	NC	NC	NC	NC	NC	NC	NC	NC	NC
	-	-	-	-	DGND	-	-	-	-	-	-	-	-	-
H	NC	NC	NC	NC	NC	NC	NC	NC	VSS	NC	NC	NC	NC	NC
	-	-	-	-	-	-	-	-	DGND	-	-	-	-	-
J	NC	NC	NC	NC	NC	NC	NC	NC	VCC	NC	NC	NC	NC	NC
	-	-	-	-	-	-	-	-	3.3 V	-	-	-	-	-
K	NC	NC	NC	NC	RST_n	NC	NC	VSS	VCC	NC	NC	NC	NC	NC
	-	-	-	-	-	-	-	DGND	3.3 V	-	-	-	-	-
L	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC
	-	-	-	-	-	-	-	-	-	-	-	-	-	-
M	NC	NC	NC	VCCQ	CMD	CLK	NC	NC	NC	NC	NC	NC	NC	NC
	-	-	-	3.3 V	H/L	H/L	-	-	-	-	-	-	-	-
N	NC	VSSQ	NC	VCCQ	VSSQ	NC	NC	NC	NC	NC	NC	NC	NC	NC
	-	DGND	-	3.3 V	DGND	-	-	-	-	-	-	-	-	-
P	NC	NC	VCCQ	VSSQ	VCCQ	VSSQ	NC	NC	NC	NC	NC	NC	NC	NC
	-	-	3.3 V	DGND	3.3 V	DGND	-	-	-	-	-	-	-	-

BLOCK DIAGRAMS

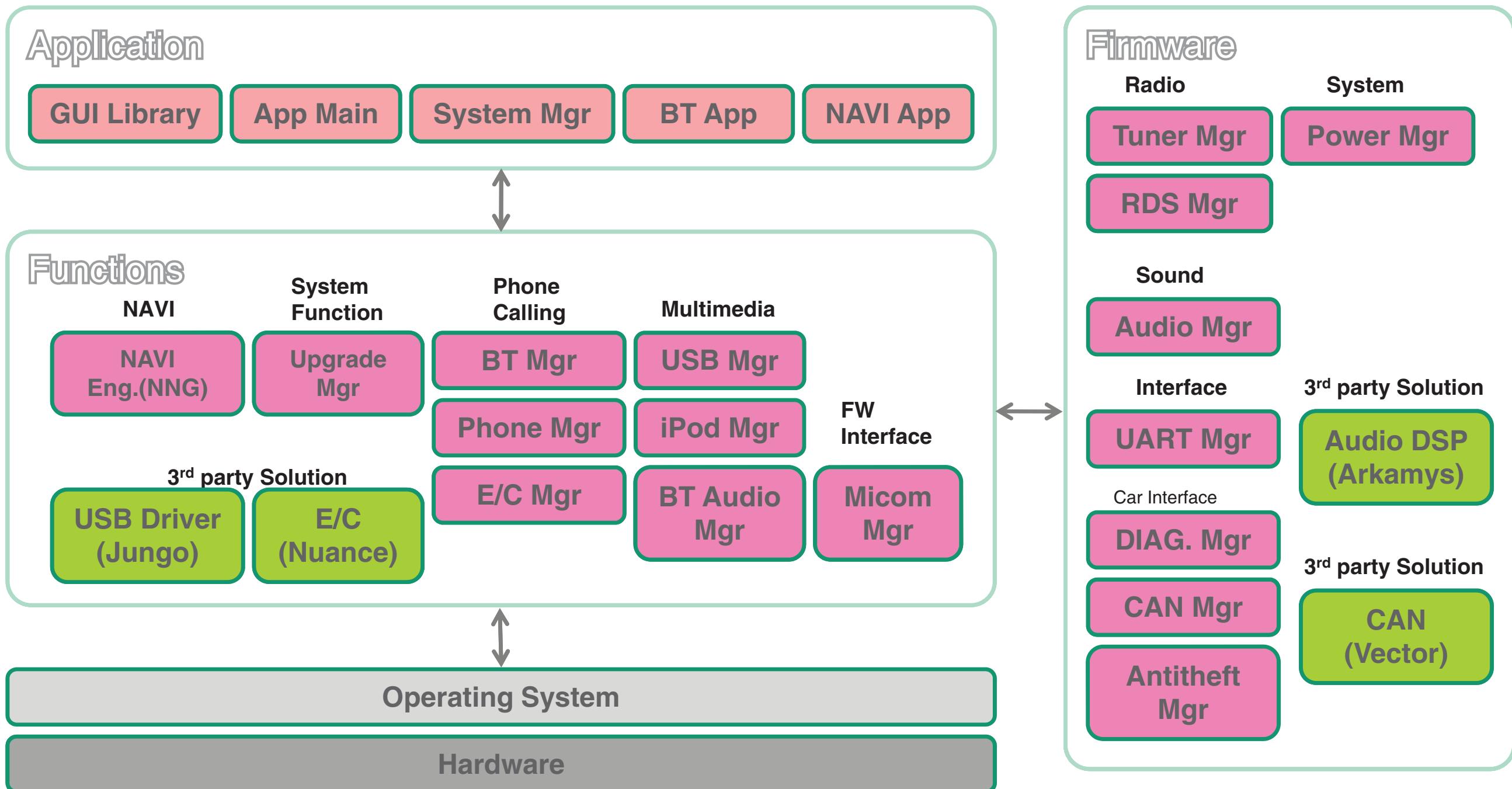
1. FUNCTION BLOCK DIAGRAM



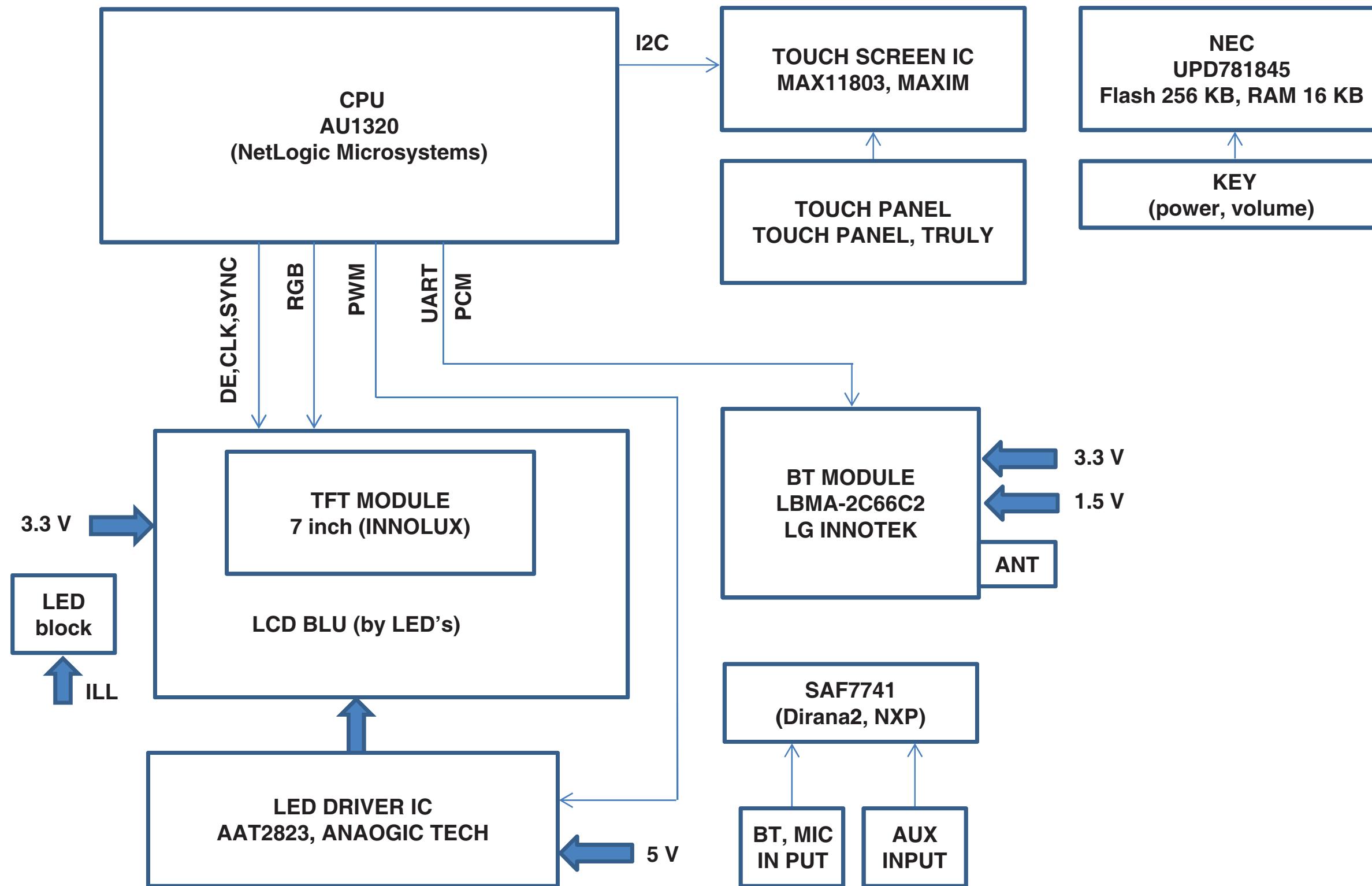
2. H/W BLOCK DIAGRAM



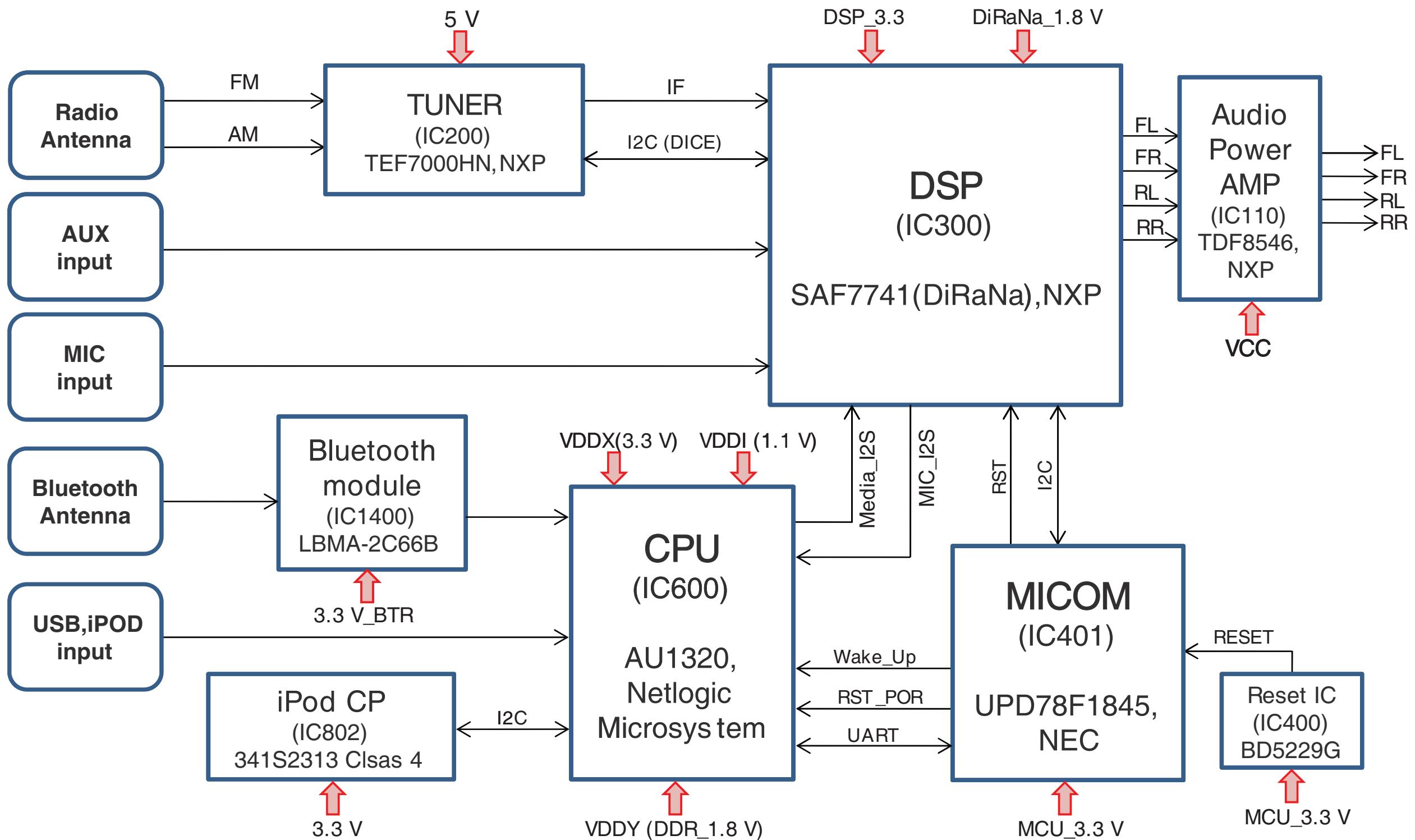
3. S/W BLOCK DIAGRAM



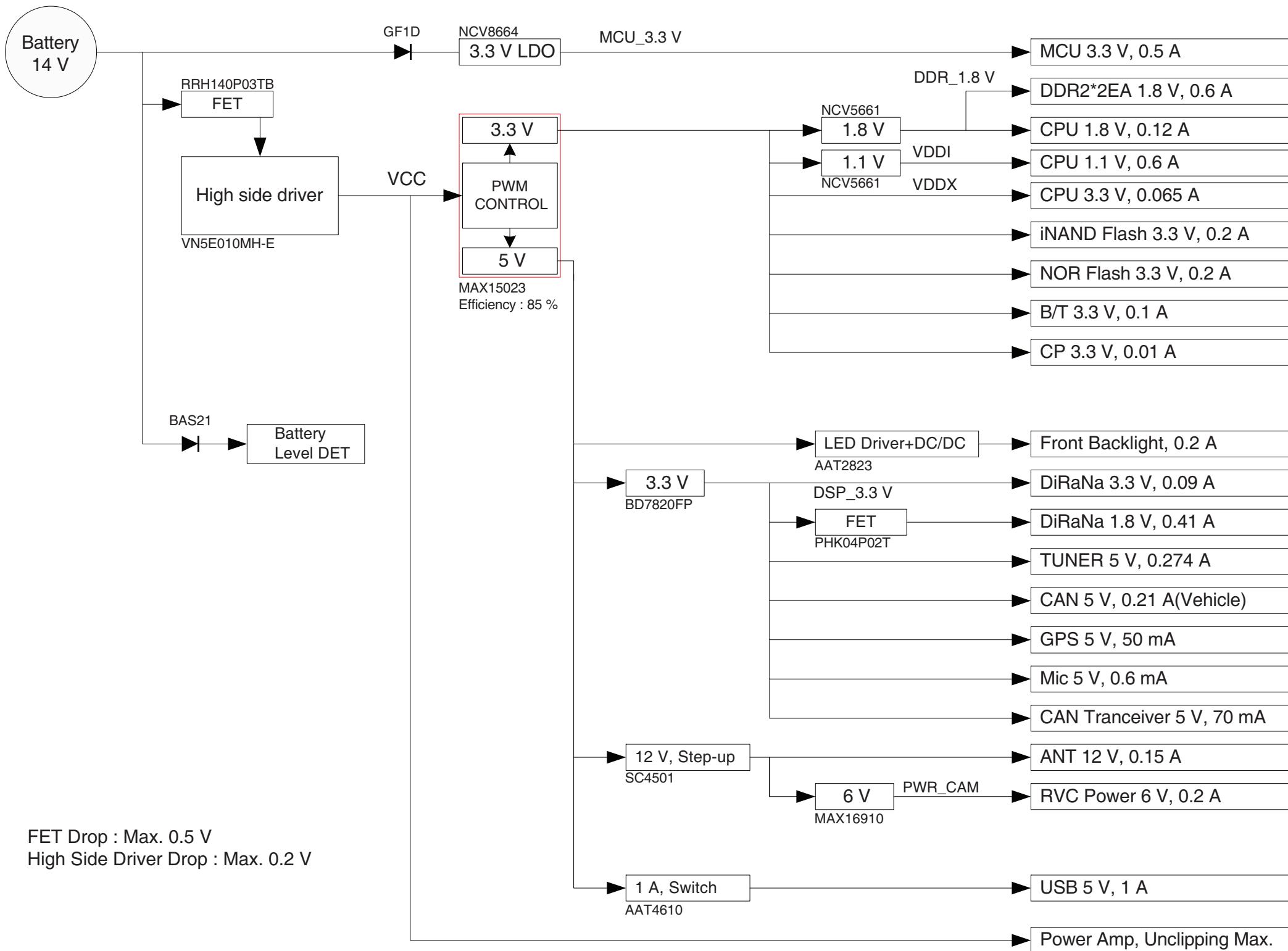
4. FRONT BLOCK DIAGRAM



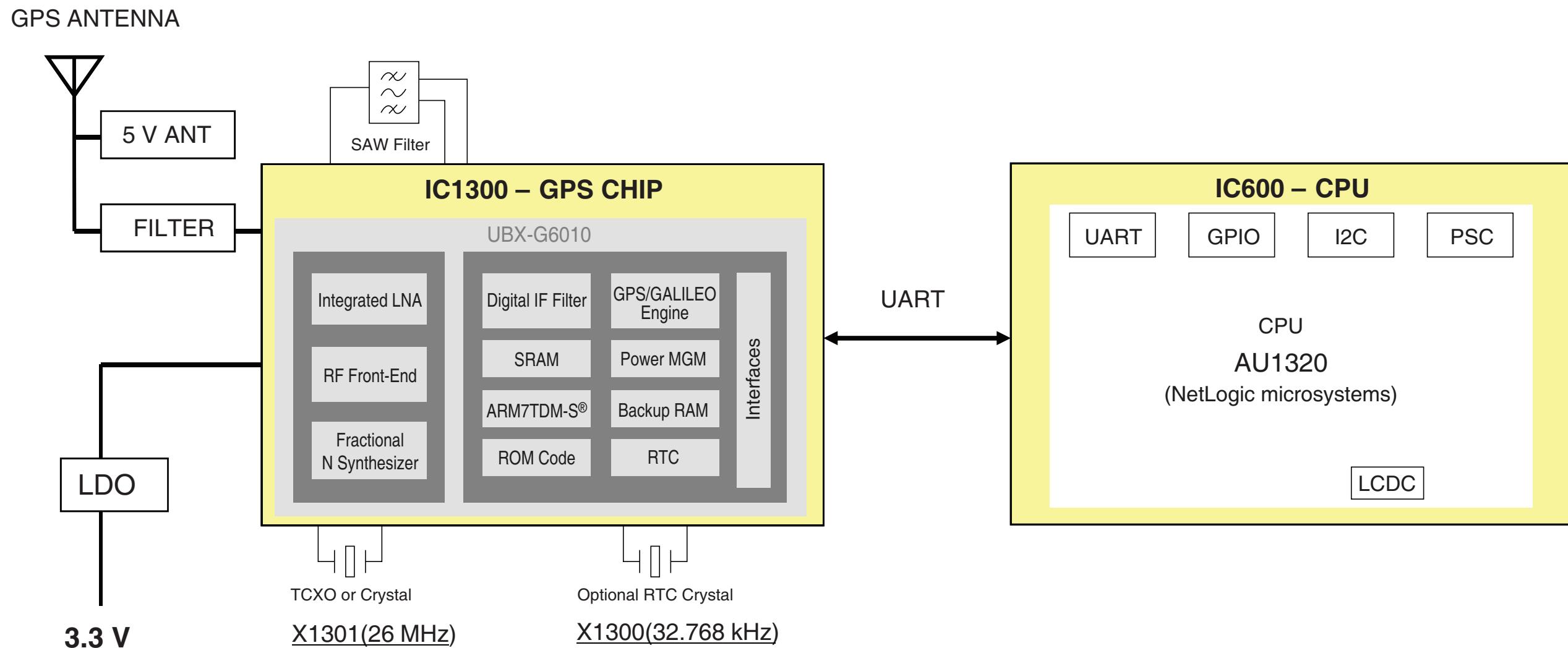
5. AUDIO BLOCK DIAGRAM



6. POWER BLOCK DIAGRAM

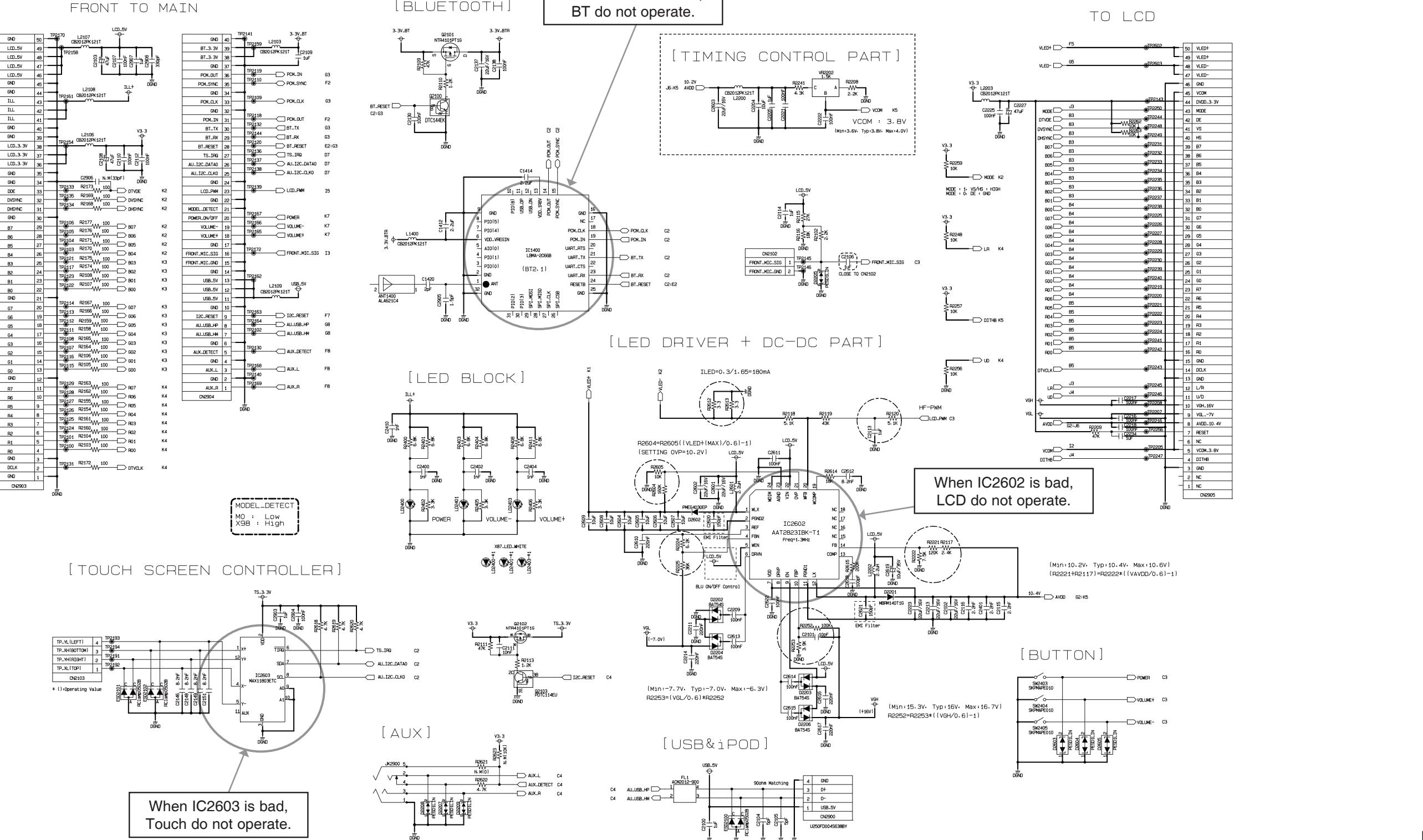


7. GPS BLOCK DIAGRAM

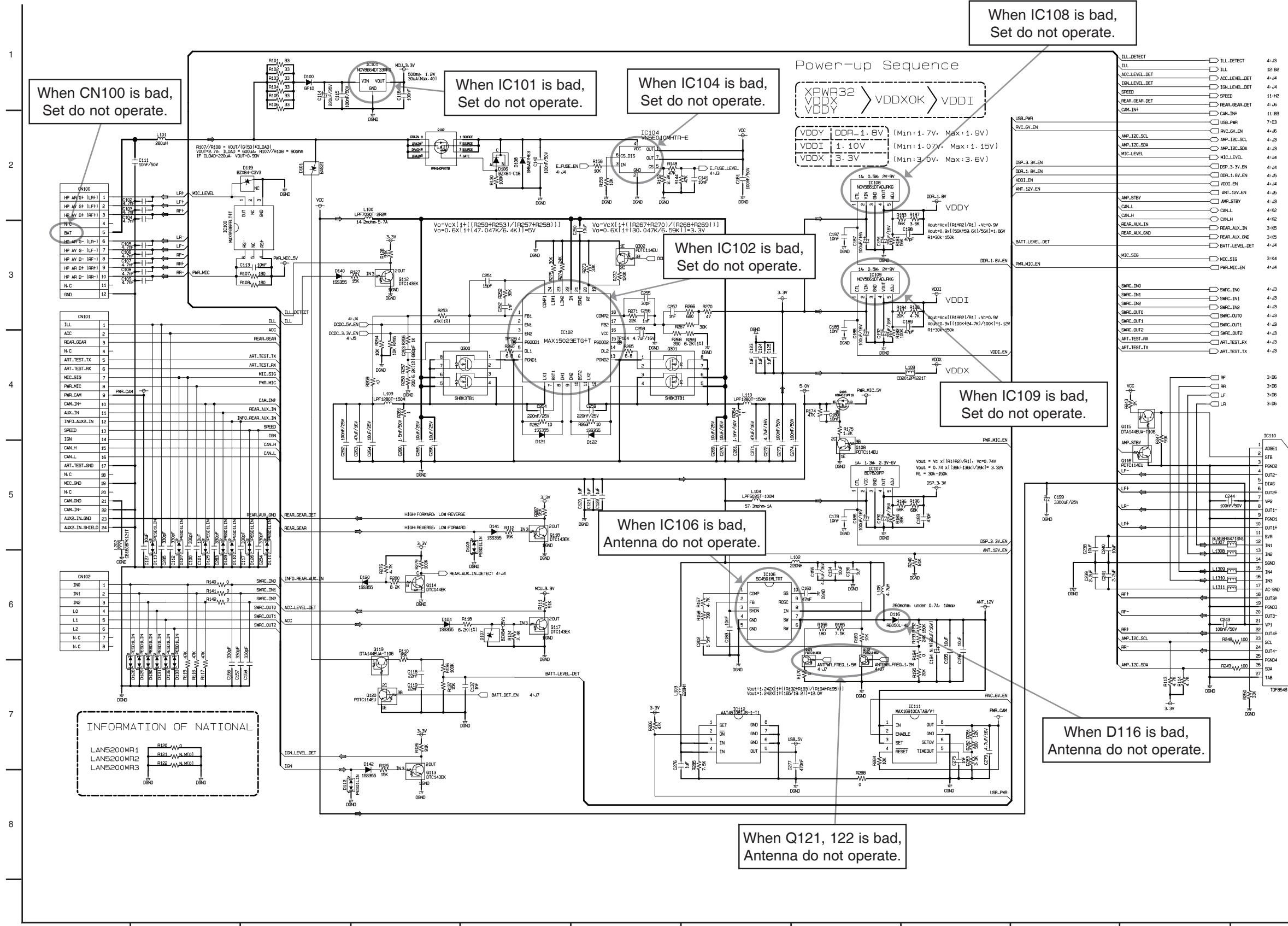


CIRCUIT DIAGRAMS

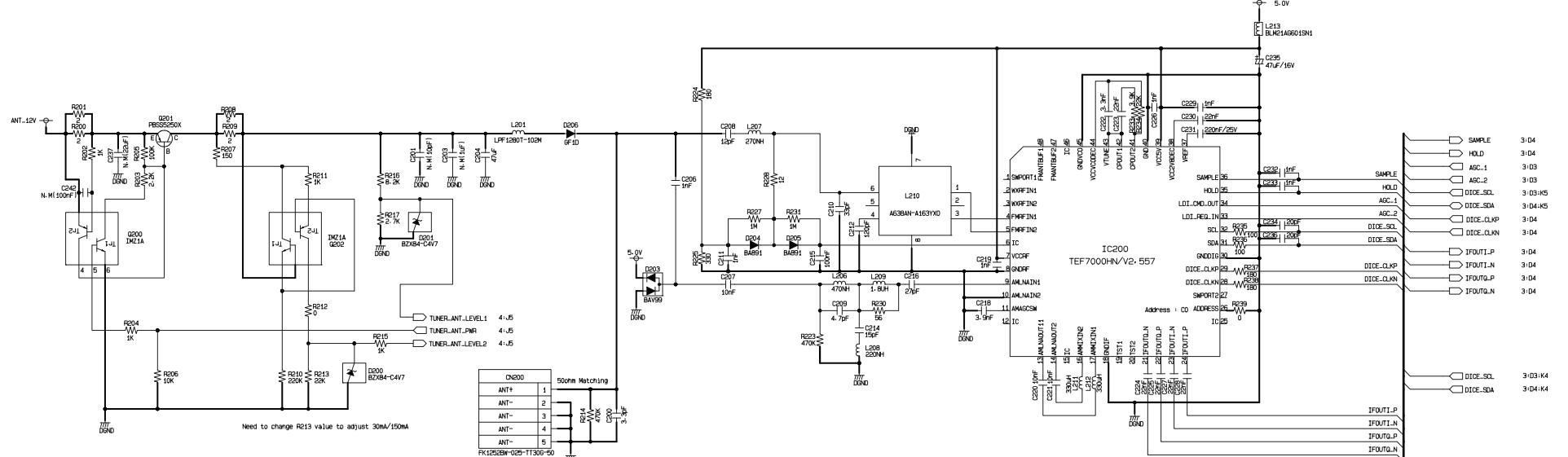
1. FRONT CIRCUIT DIAGRAM



2. MAIN - POWER + AMPLIFIER CIRCUIT DIAGRAM



3. MAIN - SINGLE RF TUNER(LEAF DICE) CIRCUIT DIAGRAM



MAIN - SINGLE RF TUNER(LEAF DICE)
EAX64206903_0_1.0-SD(#2)
2012. 02. 03

A

B

C

D

E

F

G

H

I

J

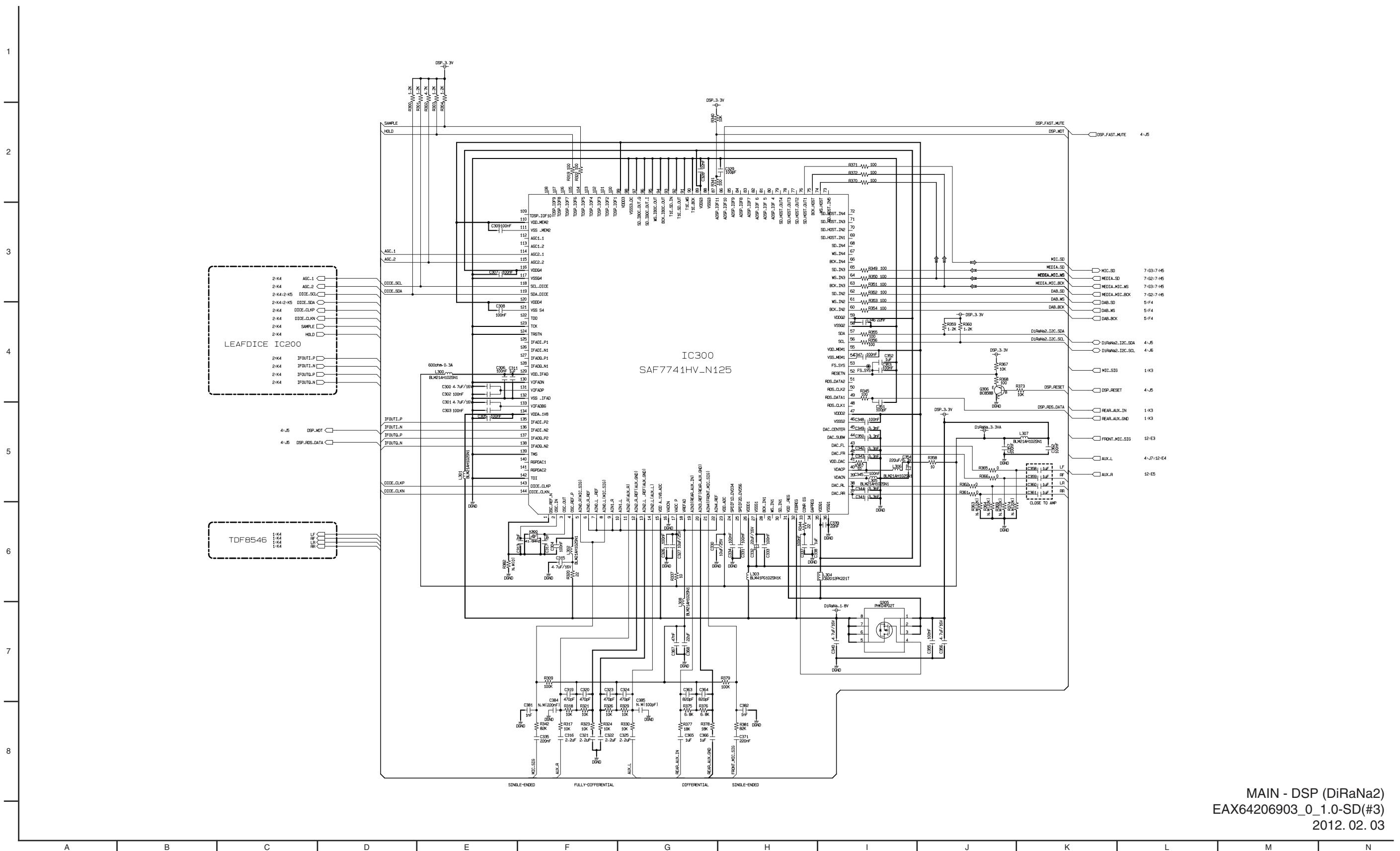
K

L

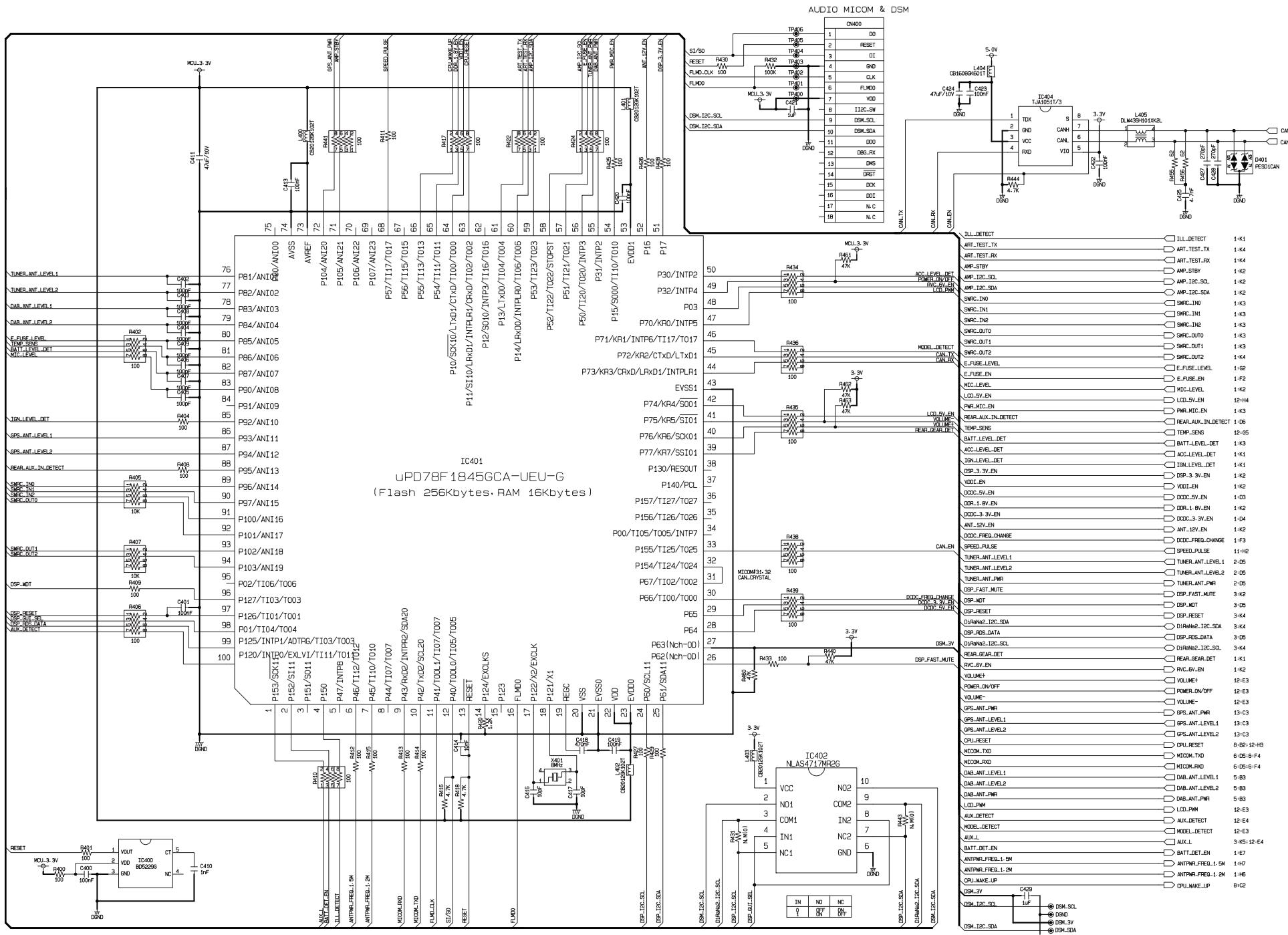
M

N

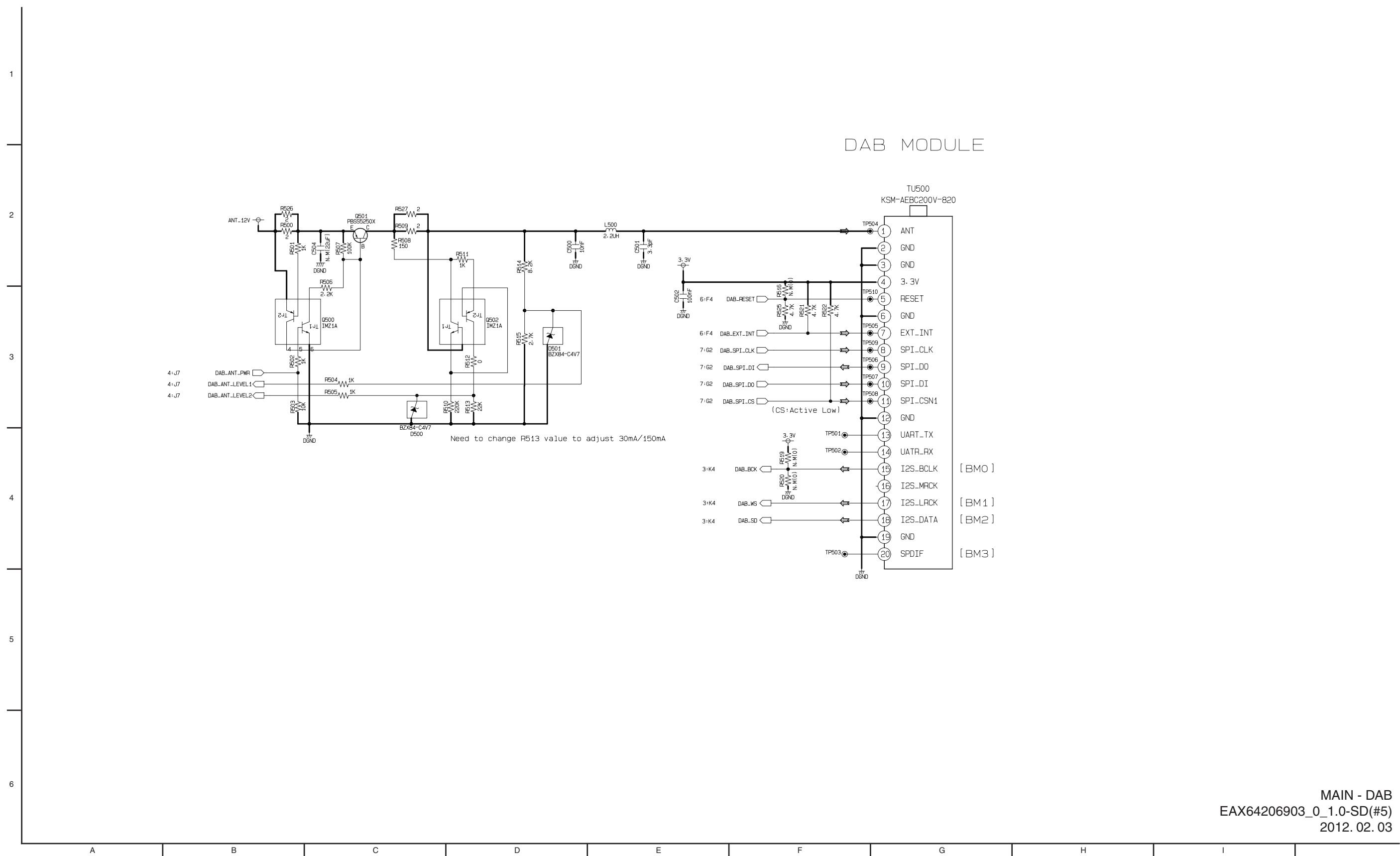
4. MAIN - DSP(DiRaNa2) CIRCUIT DIAGRAM



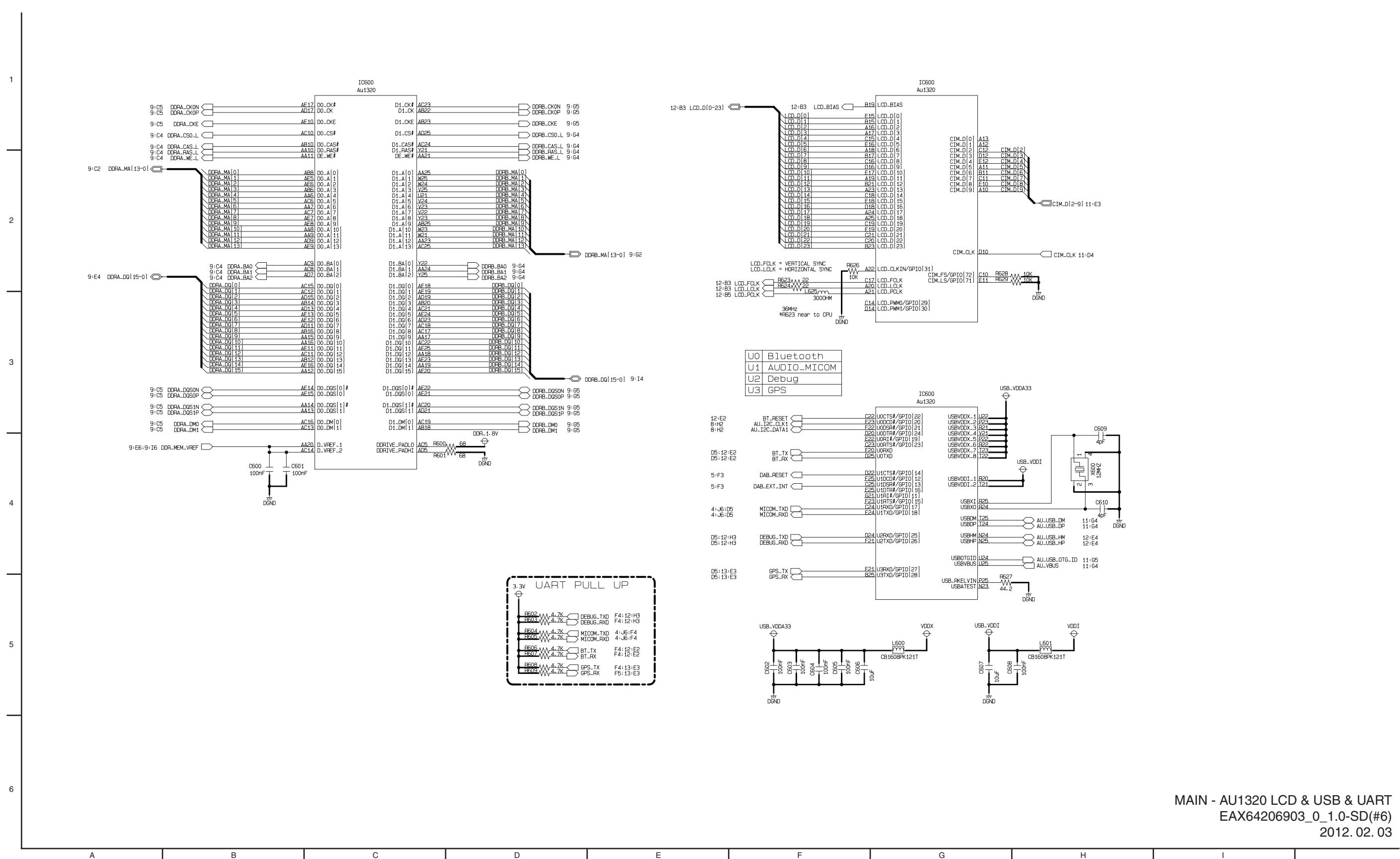
5. MAIN - MICOM + CAN CIRCUIT DIAGRAM



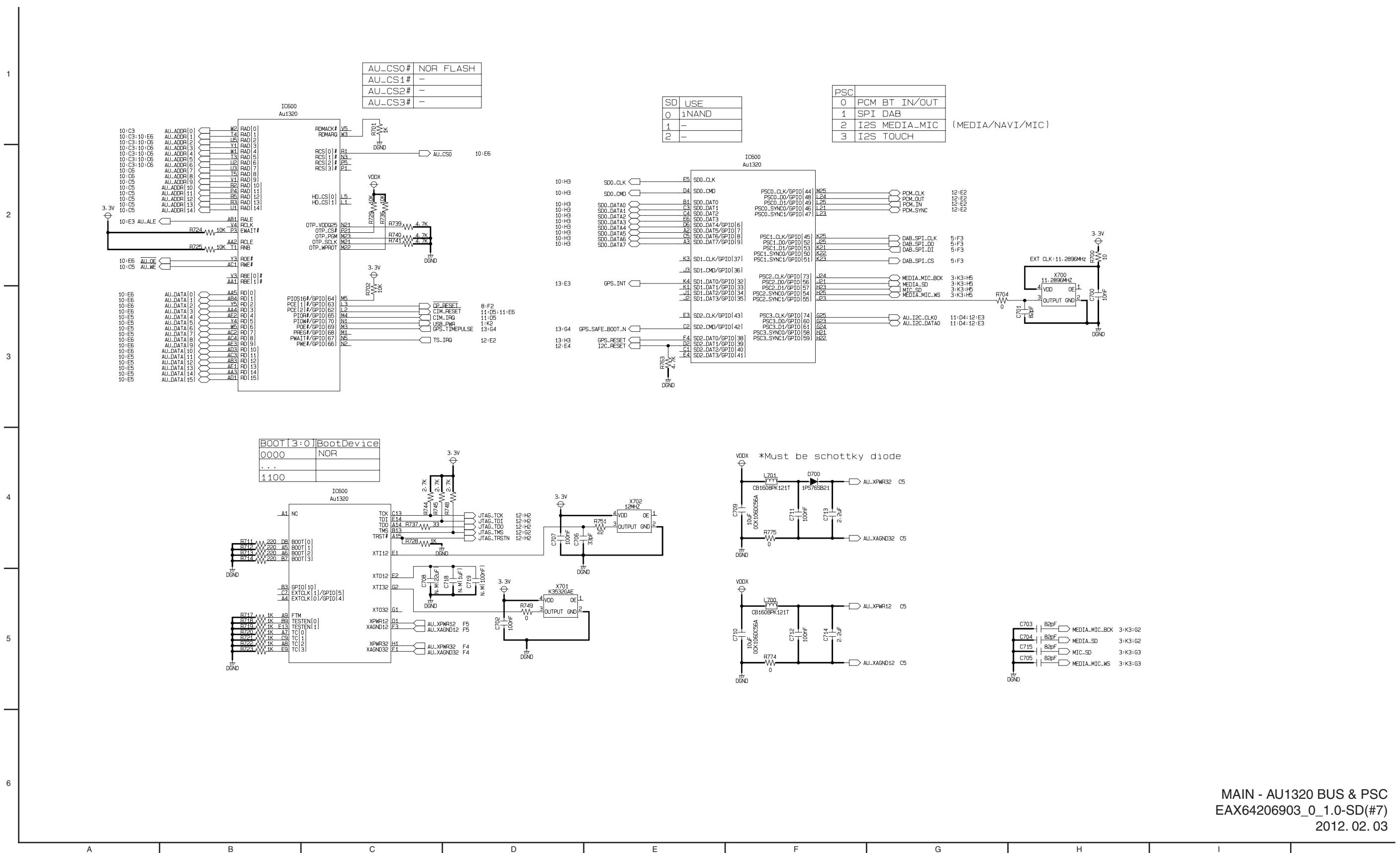
6. MAIN - DAB CIRCUIT DIAGRAM



7. MAIN - AU1320 LCD & USB & UART CIRCUIT DIAGRAM

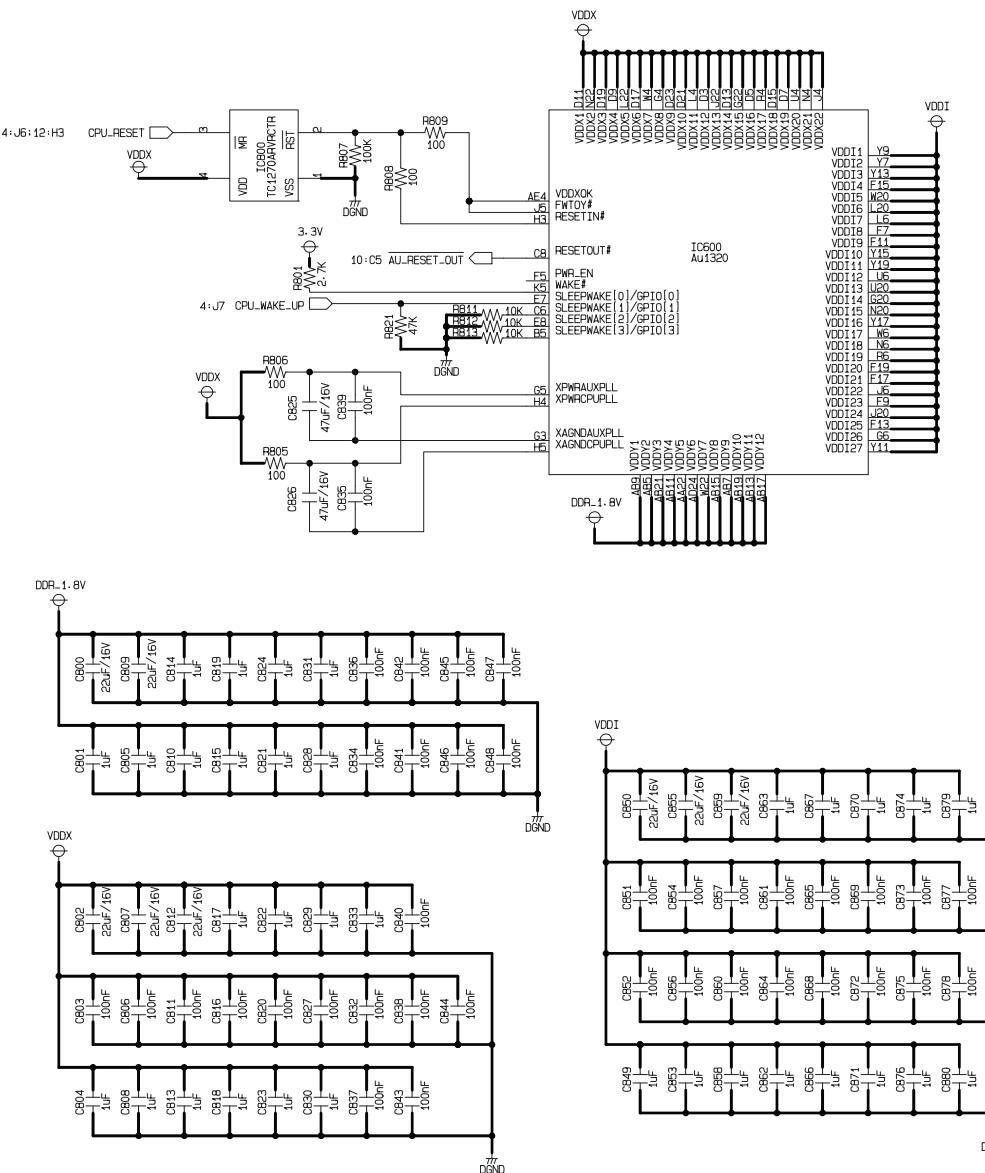


8. MAIN - AU1320 BUS & PSC CIRCUIT DIAGRAM

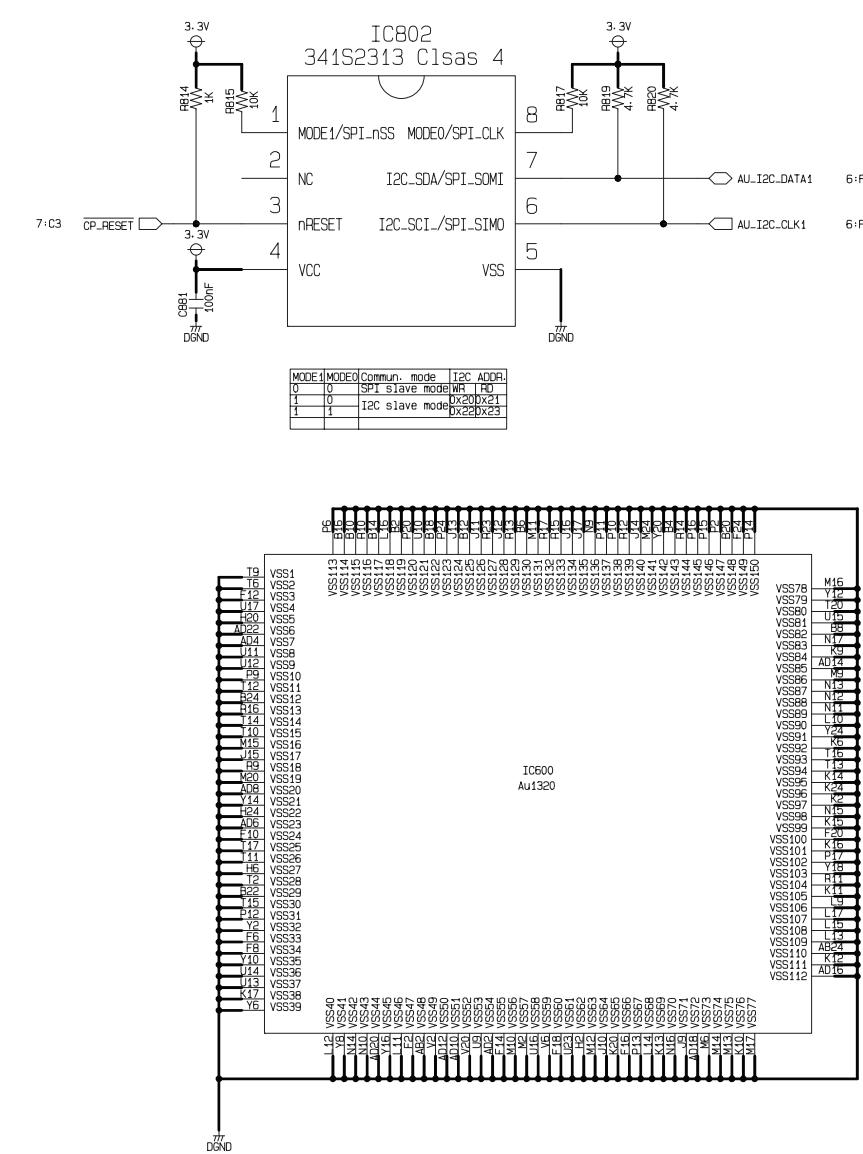


9. MAIN - AU1320 VDD & BOOT & RESET / IPOD CP CIRCUIT DIAGRAM

1
2
3
4
5
6



2-63

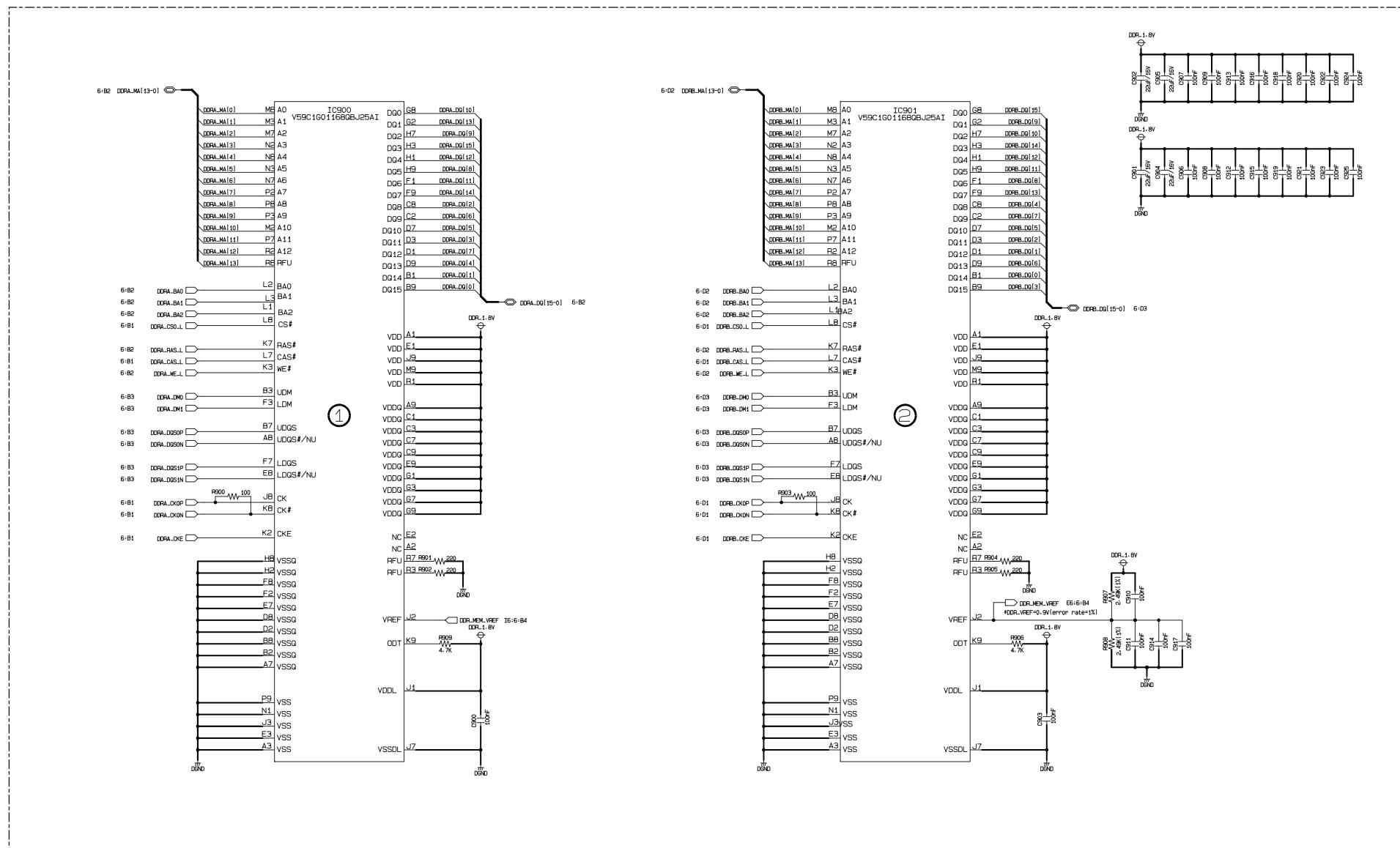


2-64

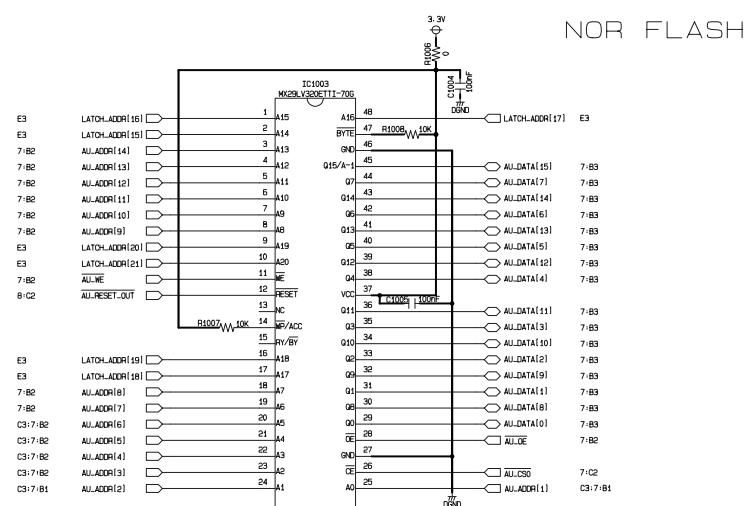
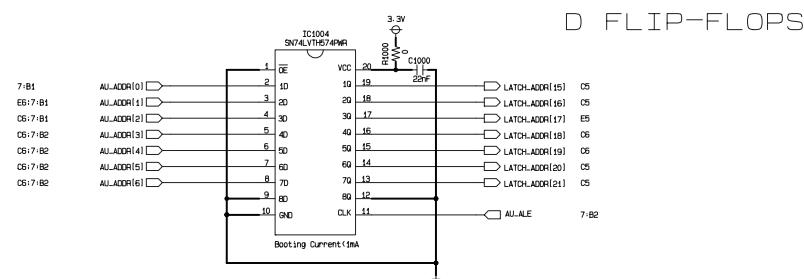
MAIN - AU1320 VDD & BOOT & RESET / IPOD CP
EAX64206903_0_1.0-SD(#8)
2012. 02. 03

10. MAIN - DDR2 SDRAM CIRCUIT DIAGRAM

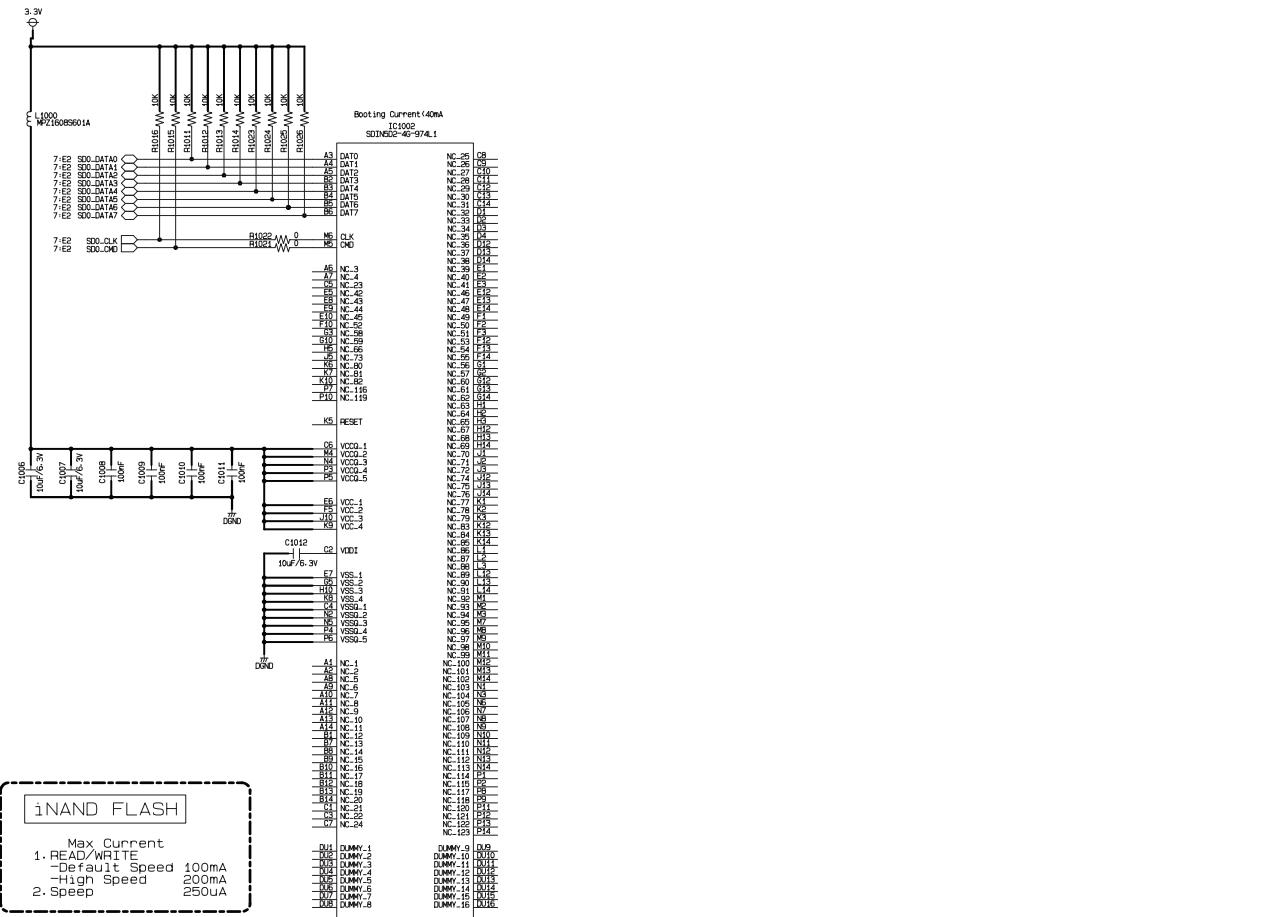
128MByte X 2 : DDR2 Single 32-bit Interface with One Rank
(V59C1G01168QB, HIGH PERFORMANCE 1Gbit DDR2 SDRAM, 8BANKS X 8Mbit X 16(168))



11. MAIN - NOR FLASH & i-NAND CIRCUIT DIAGRAM



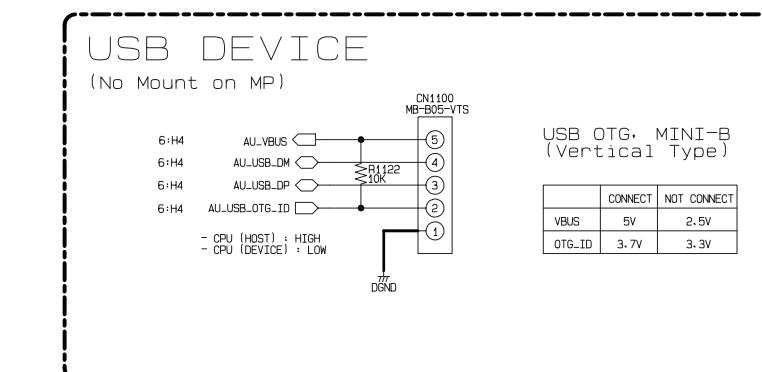
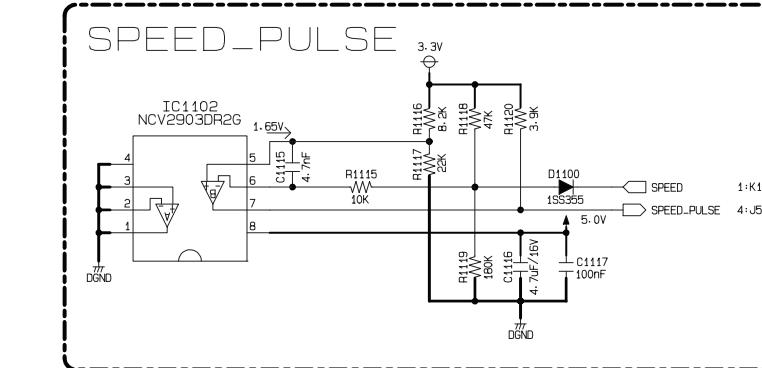
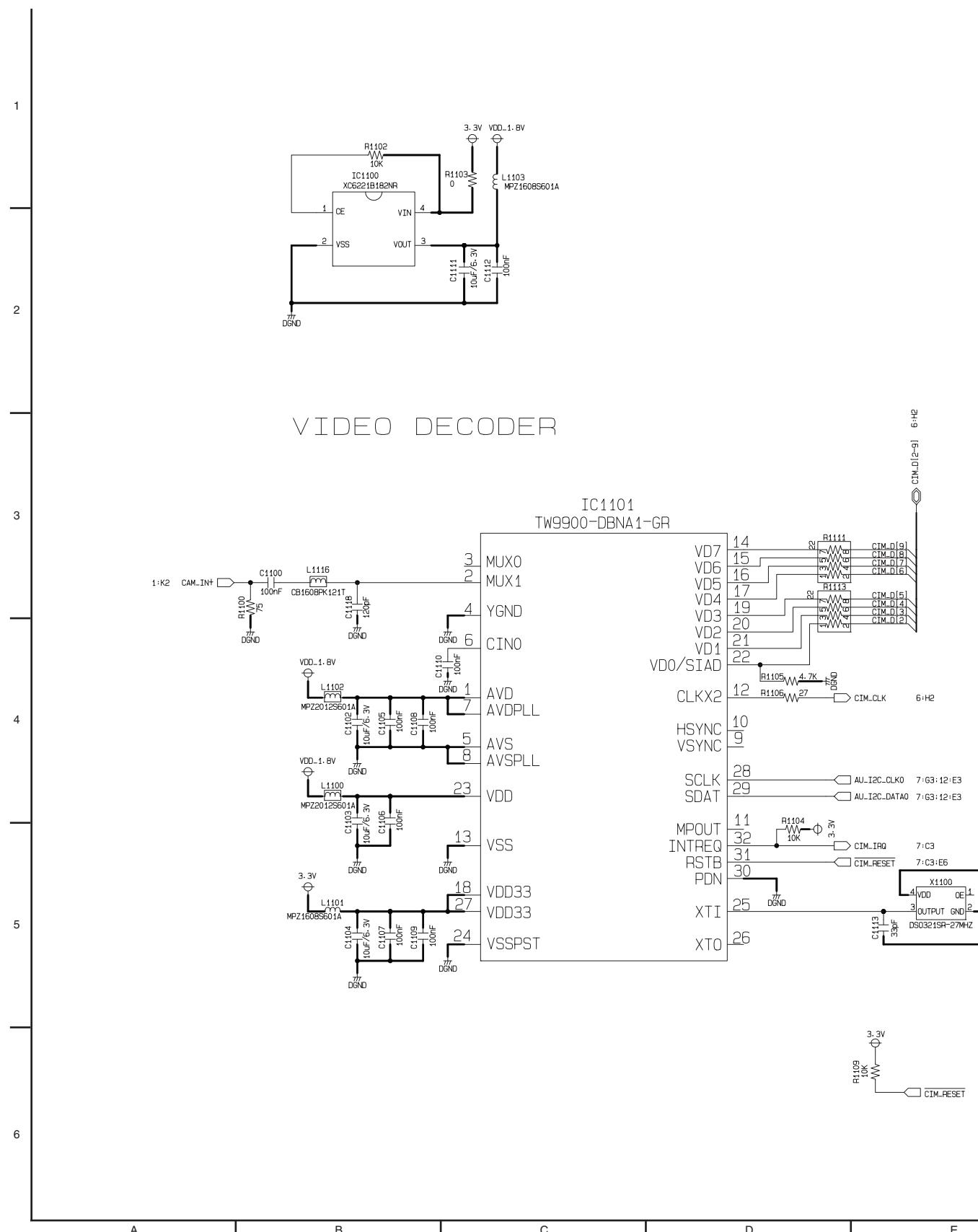
i-NAND FLASH



MAIN - NOR FLASH & i-NAND
EAX64206903_0_1.0-SD(#10)
2012. 02. 03

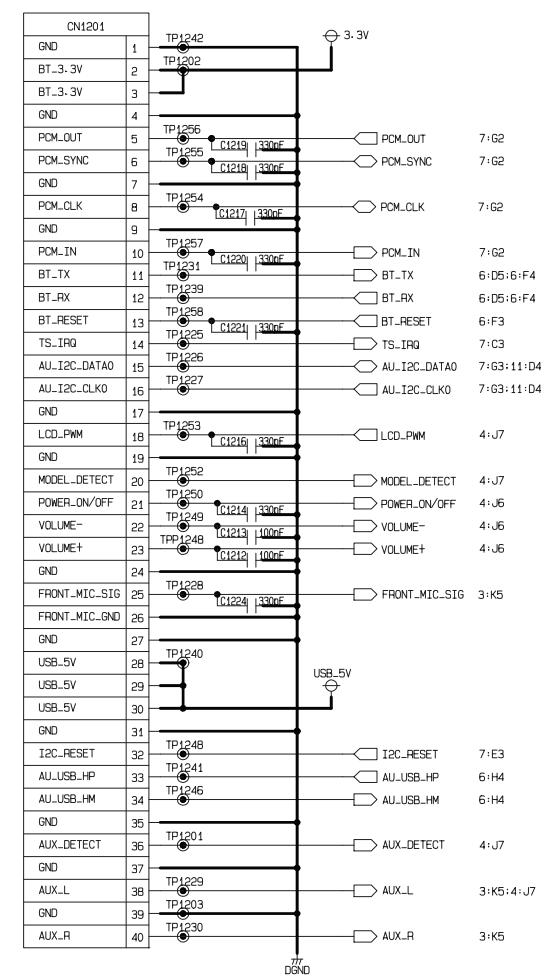
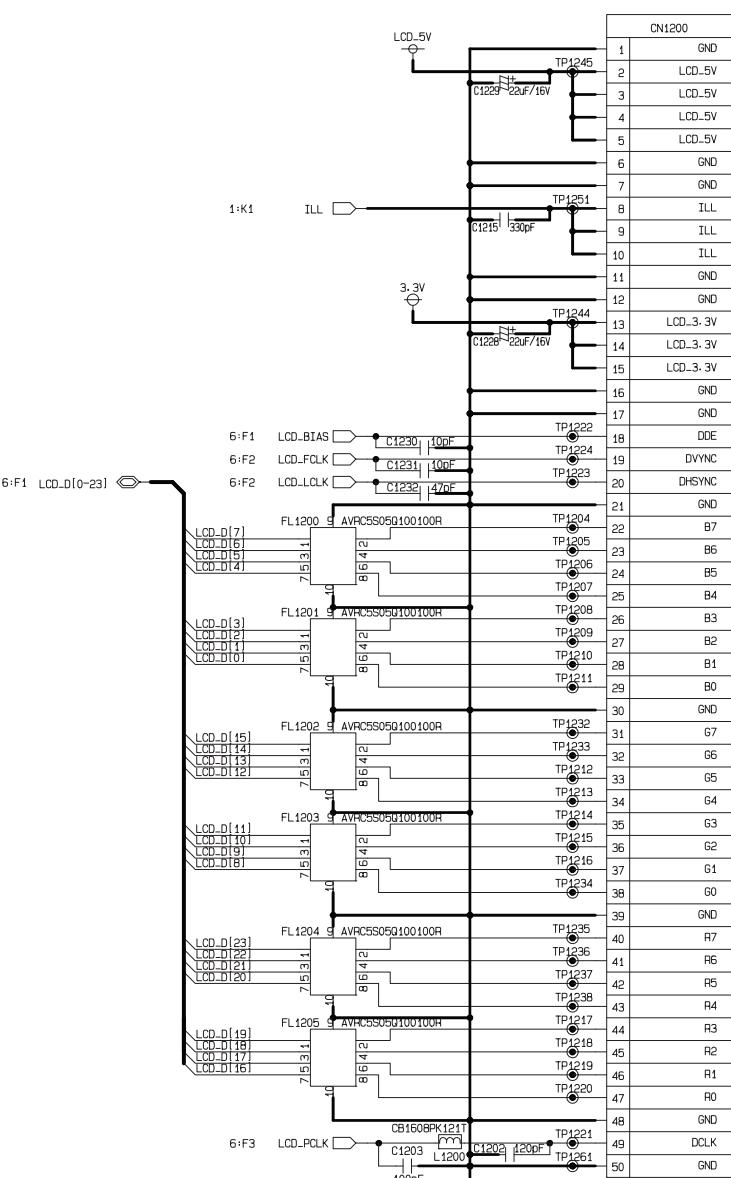
A | B | C | D | E | F | G | H | I | J | K | L | M | N

12. MAIN - VIDEO DECODER & USB CIRCUIT DIAGRAM

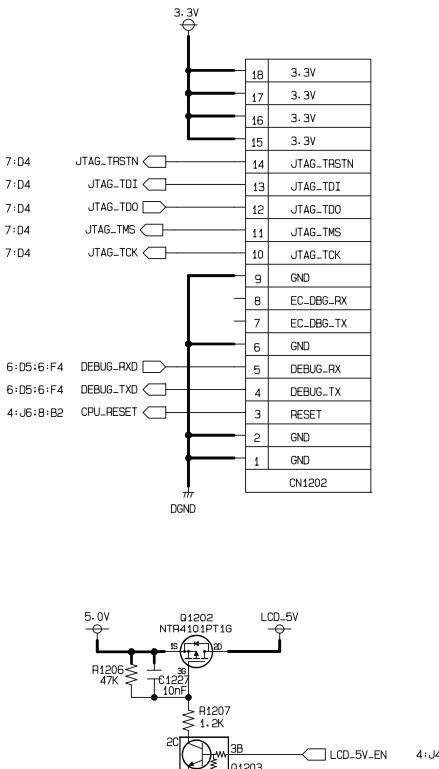


13. MAIN - CONNECTOR & DEBUG CIRCUIT DIAGRAM

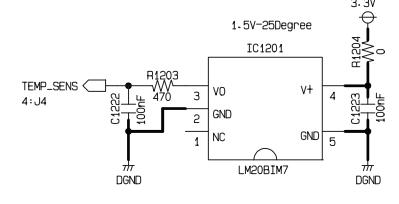
MAIN TO FRONT



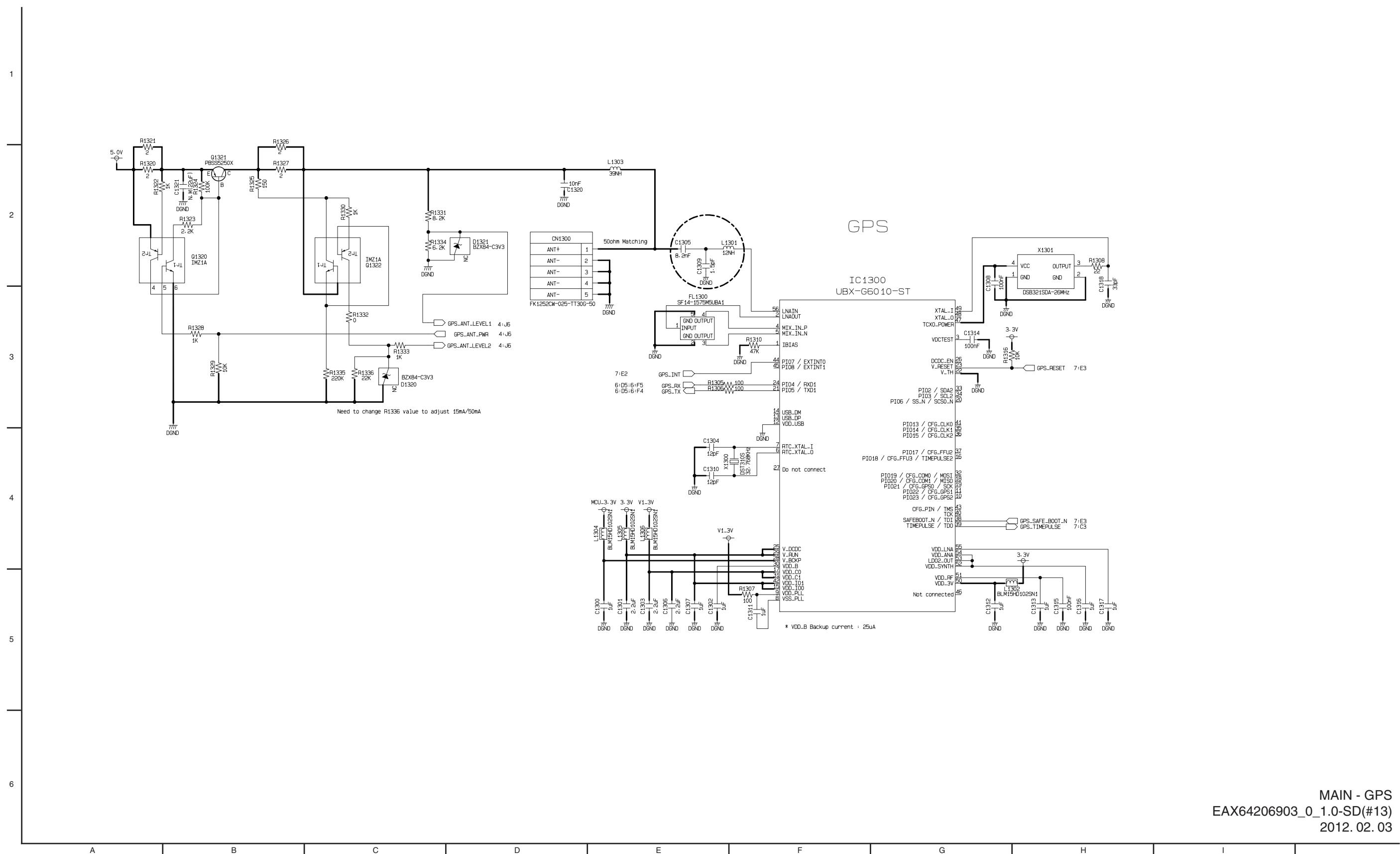
DEBUG



TEMP



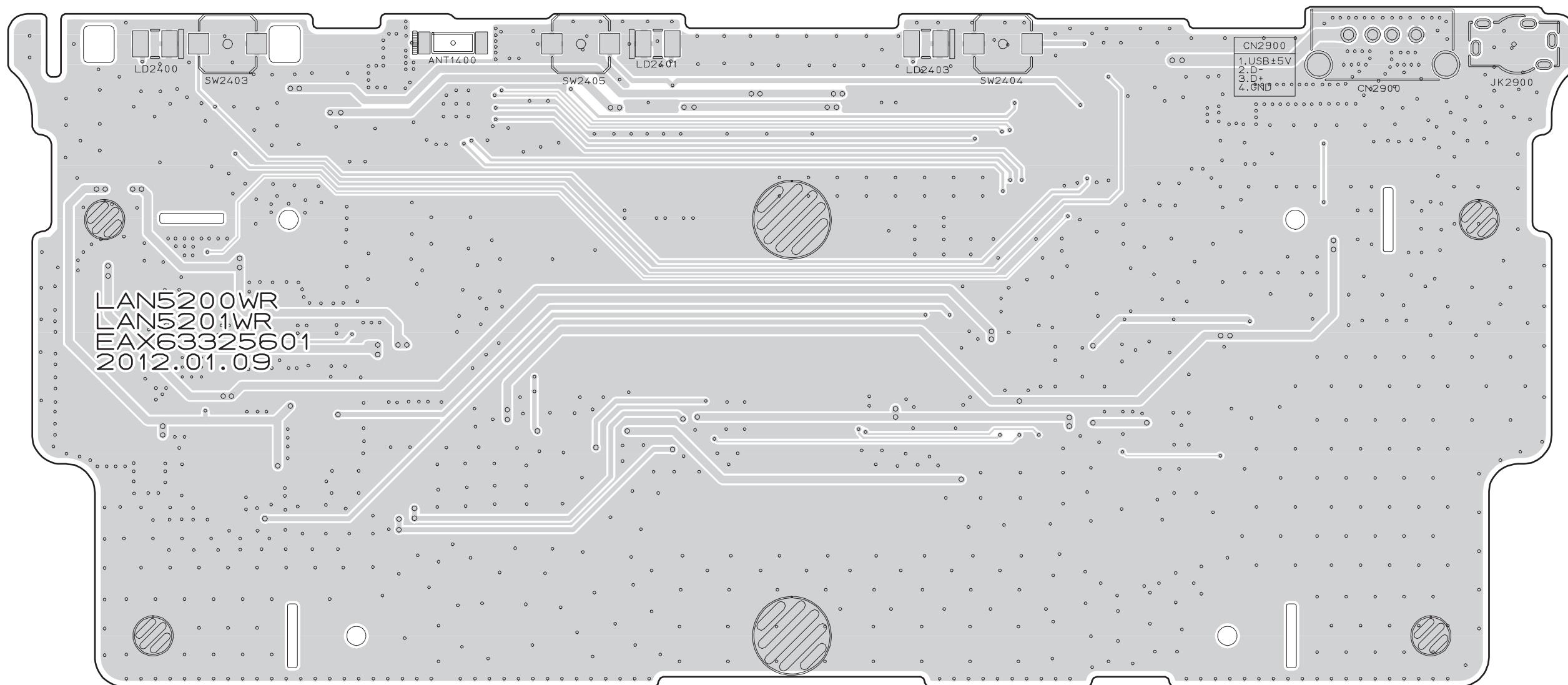
14. MAIN - GPS CIRCUIT DIAGRAM



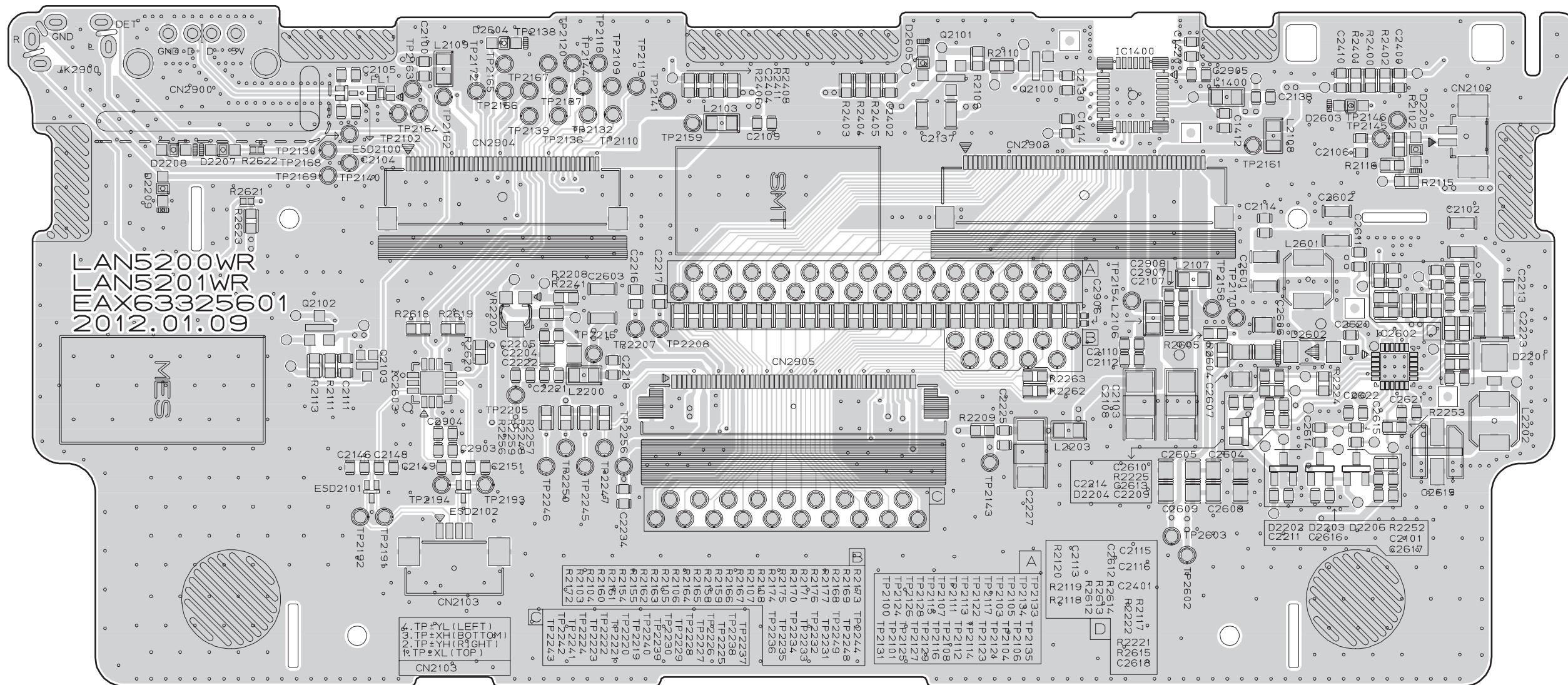
PRINTED CIRCUIT BOARD DIAGRAMS

1. FRONT P.C.BOARD

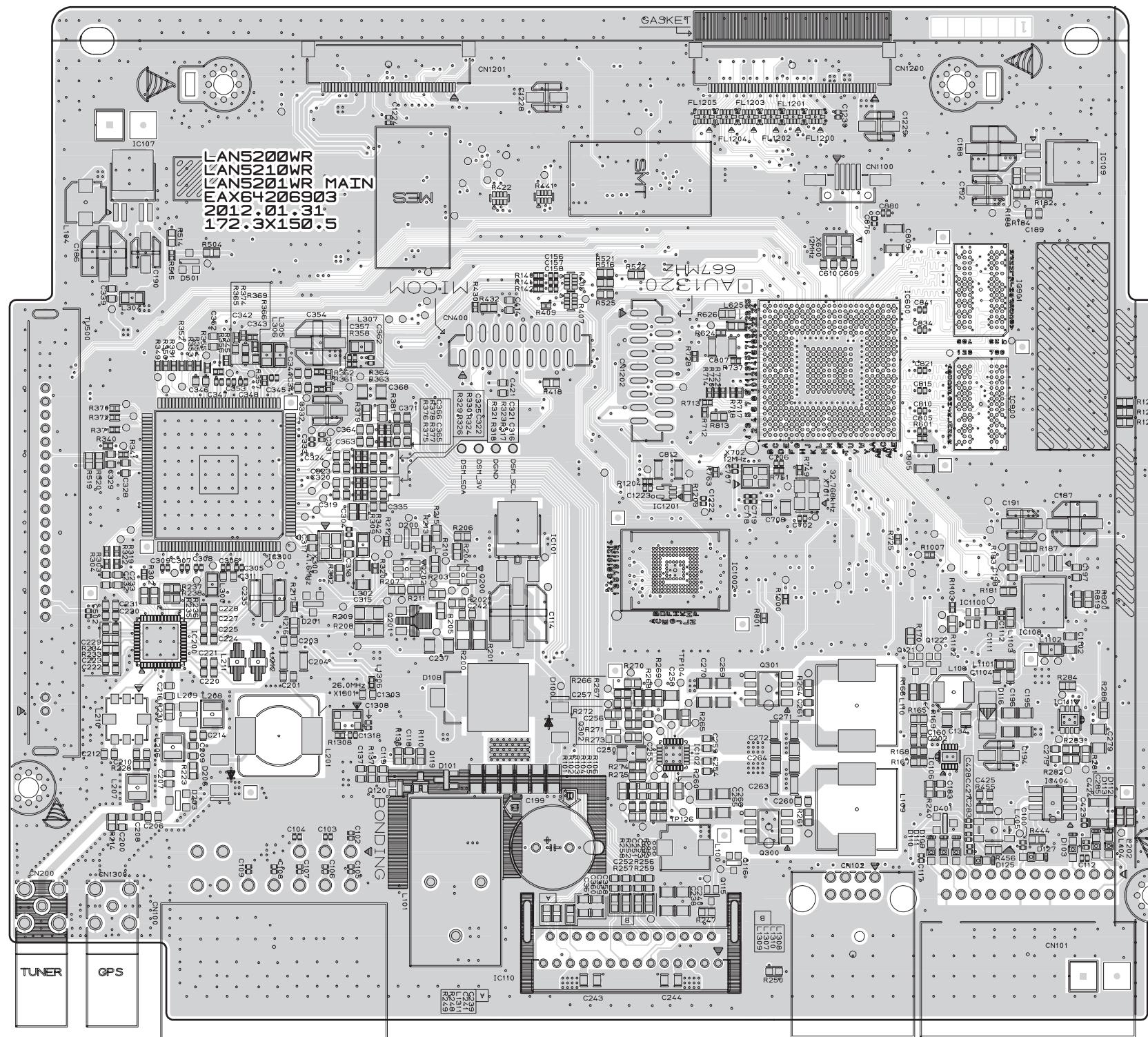
(TOP VIEW)



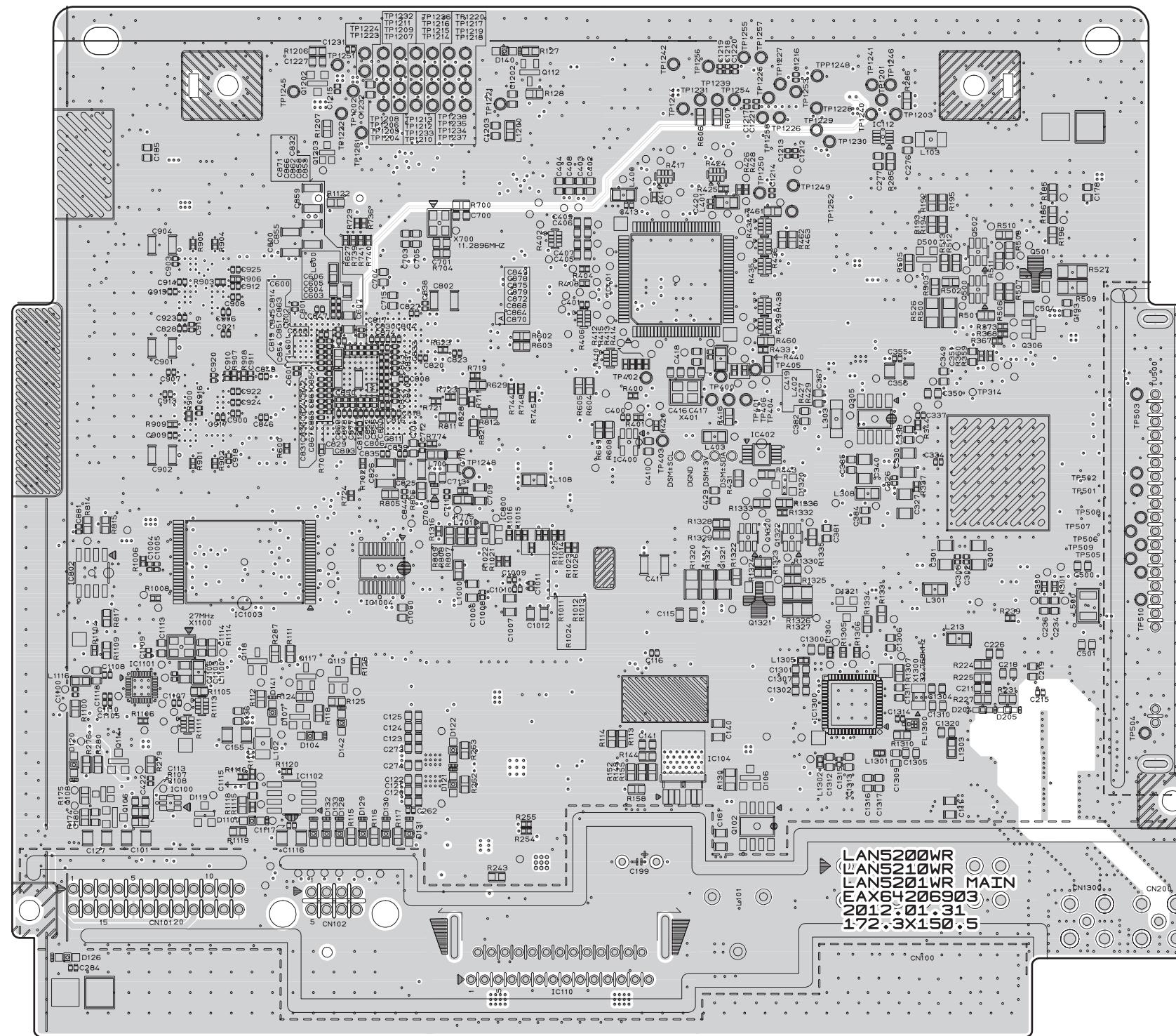
(BOTTOM VIEW)



2. MAIN P.C.BOARD (TOP VIEW)



(BOTTOM VIEW)



MEMO

MEMO

SECTION 3 EXPLODED VIEW

1. CABINET AND MAIN FRAME SECTION

